

MAX20734

Integrated, Step-Down Switching Regulator with PMBus

General Description

The MAX20734 is a fully integrated, highly efficient switching regulator with PMBus™ for applications operating from 4.5V to 16V and requiring up to 40A (max) load. This single-chip regulator provides extremely compact, high-efficiency power-delivery solutions with high-precision output voltages and excellent transient response for networking, datacom, and telecom equipment.

The IC offers a broad range of programmable features through either the PMBus or a capacitor and resistor connected to a dedicated programming pin. Using this feature, the operation can be optimized for a specific application, reducing the component count and/or setting appropriate trade-offs between the regulator's performance and system cost. Ease of programming enables using the same design for multiple applications.

The IC includes protection and telemetry features. Positive and negative cycle-by-cycle overcurrent protection and overtemperature protection ensure a rugged design. Input undervoltage lockout shuts down the device to prevent operation when the input voltage is out of specification. A status pin provides an output signal to show that the output voltage is within range and the system is regulating.

Applications

- Communications Equipment
- Networking Equipment
- Servers and Storage Equipment
- Point-of-Load Voltage Regulators
- μ P Chipsets
- Memory V_{DDQ}
- I/O

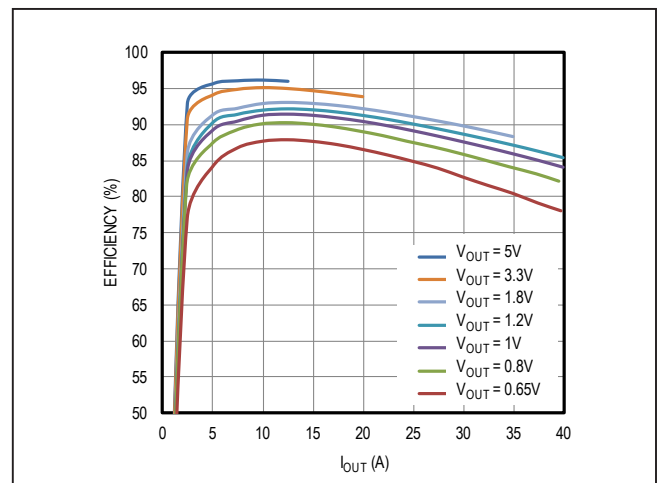
| DESCRIPTION | CURRENT RATING* | INPUT VOLTAGE | OUTPUT VOLTAGE |
|---------------------------------------------------|-----------------|---------------|----------------|
| Electrical rating | 40A | 4.5V to 16V | 0.6V to 5.5V |
| Thermal rating, $T_A = 55^\circ\text{C}$, 200LFM | 35A | 12V | 1V |
| Thermal rating, $T_A = 85^\circ\text{C}$, 0LFM | 22A | 12V | 1V |

*For specific operating conditions, refer to the SOA curves in the [Typical Operating Characteristics](#) section.

Benefits and Features

- High Power Density and Low Component Count
 - Overall Solution Size 509mm² Including Inductor and Output Capacitors
 - 90.7% Peak Efficiency with $V_{DDH} = 12\text{V}$ and $V_{OUT} = 1\text{V}$
 - Fast Transient Response: Supports Up to 300A/ μ s Load-Step Transients
- Optimized Component Performance and Efficiency with Reduced Design-In Time
 - PMBus-Compliant Interface for Telemetry and Power Management
 - Voltage, Current, and Temperature Reporting through the Digital Bus
- Increased Power-Supply Reliability with System and IC Self-Protection Features
 - Differential Remote Sense with Open-Circuit Detection
 - Hiccup Overcurrent Protection
 - Programmable Thermal Shutdown

Typical System Efficiency vs. Load Current ($V_{DDH} = 12\text{V}$)



[Order Information](#) appears at end of data sheet.

PMBus is a trademark of SMIF, Inc.

Absolute Maximum Ratings

| | | | |
|----------------------------------------------------------------------|---------------|-------------------------------------------|-----------------|
| Input Pin Voltage (V _{DDH}) (Note 1) | -0.3V to +18V | Switching Node Voltage (VX) DC | -0.3V to +18V |
| V _{CC} | -0.3V to +2V | Switching Node Voltage (VX) 25ns (Note 2) | -10V to +23V |
| STAT, OE, CLK, DATA, and SMALERT Pin Voltages | -0.3V to +4V | (BST - VX) Pin Differential | -0.3V to +2.5V |
| PGMA, PGMB, V _{SENSE+} and V _{SENSE-} Pin Voltages | -0.3V to +2V | Junction Temperature (T _J) | +150°C |
| | | Storage Temperature Range | -65°C to +150°C |
| | | Peak Reflow Temperature Lead-Free | +260°C |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Operating Ratings

| | | | |
|----------------------------------------|-----------------|----------------------------------------------------------------|-----|
| Input Voltage (V _{DDH}) | 4.5V to 16V | Maximum Average Input Current (V _{DDH_MAX}) (Note 3) | 6A |
| Junction Temperature (T _J) | -40°C to +125°C | Maximum Average Output Current (I _{MAX}) | 40A |
| | | Peak Output Current (I _{PK}) | 90A |

Package Information

| | |
|----------------------------------------------------------------------------|---------------------------|
| PACKAGE TYPE: 15 FCQFN | |
| Package Code | P154A9F+1 |
| Outline Number | 21-100027 |
| Land Pattern Number | 90-100025 |
| THERMAL RESISTANCE | |
| Junction to Ambient (θ _{JA}) (Note 4; Still Air, No Heatsink) | 12°C/W |
| Junction to Case (θ _{JC}) | 0.42°C/W |

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

- Note 1:** As measured at the V_{DDH} pin referenced to GND pin immediately adjacent using a high-frequency scope probe with I_{LOAD} at I_{MAX}. A high-frequency input bypass capacitor must be located less than 60 mils from the V_{DDH} pin per our design guidelines.
- Note 2:** The 25ns rating is the allowable voltage on the VX node in excess of the -0.3V to +18V DC ratings. The VX voltage may exceed the DC rating in either the positive or negative direction for up to 25ns per cycle.
- Note 3:** See the [Average Input Current Limit](#) section.
- Note 4:** Data taken using Maxim's evaluation kit (MAX20734EVKIT#). The PCB has four layers of 2oz copper.

Electrical Characteristics

(Circuit of [Figure 6](#), $V_{DDH} = 4.5V$ to $16V$, $T_A = +25^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$. All devices 100% tested at $T_A = +25^\circ C$. Limits over temperature guaranteed by design.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|------------------------------------------------------------------|----------------|----------------------------------------------------------------------------------------------|--------|--------|------|-------------|
| SUPPLY VOLTAGE | | | | | | |
| Supply-Voltage Range | V_{DDH} | $T_J = -40^\circ C$ to $+125^\circ C$ | 4.5 | | 16 | V |
| OUTPUT VOLTAGE (Note 5) | | | | | | |
| Output-Voltage Range | V_{OUT} | (Note 6) | 0.6 | | 5.5 | V |
| Programmable V_{OUT} Slew Rates | | Default is $1mV/\mu s$; other values are set through PMBus; measured at $V_{SENSE+/-}$ pins | | 1 | | mV/ μs |
| | | | | 2 | | |
| | | | | 4 | | |
| V_{REF} | | | | | | |
| V_{BOOT} Values | | Selected by C_SELA (Note 7) | | 0.6484 | | V |
| | | | | 0.8984 | | |
| | | | | 1.0 | | |
| V_{REF} Tolerance | V_{REF} | $V_{REF} = 0.6484V, 0.8984V,$ and $1.0V$ (Notes 6, 8), referred to $V_{SENSE+/-}$ pins | -1.0 | | +1.0 | % |
| Programmable V_{REF} Range | | See Table 8 for accuracy vs. V_{REF} (Note 7) | 0.6016 | | 1.0 | V |
| FEEDBACK LOOP | | | | | | |
| Integrator Recovery Time Constant | t_{REC} | | | 20 | | μs |
| Gain (see the <i>Control Loop Stability</i> section for details) | R_{GAIN} | Selected by R_SELB or PMBus (Notes 6, 7, 8, 9) | | 0.8 | | mV/A |
| | | | | 1.6 | | |
| | | | | 3.2 | | |
| Gain Accuracy | | (Notes 6, 8, 9) | -20 | | +20 | % |
| SWITCHING FREQUENCY | | | | | | |
| Switching Frequency | f_{SW} | 400kHz/600kHz/800kHz selected by C_SEL_B; other values are set through PMBus (Note 7) | | 400 | | kHz |
| | | | | 500 | | |
| | | | | 600 | | |
| | | | | 700 | | |
| | | | | 800 | | |
| | | | | 900 | | |
| Switching Frequency Accuracy | | (Notes 6, 8, 9) | -20 | | +20 | % |
| INPUT PROTECTION | | | | | | |
| Rising V_{DDH} UVLO Threshold | V_{DDH} UVLO | (Note 6) | | 4.25 | 4.47 | V |
| Falling V_{DDH} UVLO Threshold | | | | 3.7 | 3.9 | |
| Hysteresis | | | | | | 350 |

Electrical Characteristics (continued)

(Circuit of [Figure 6](#), $V_{DDH} = 4.5V$ to $16V$, $T_A = +25^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$. All devices 100% tested at $T_A = +25^\circ C$. Limits over temperature guaranteed by design.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | |
|------------------------------------------------------------|-----------|-----------------------------------------------------------------------|-----------------|------|------|------------|------------|
| OUTPUT-VOLTAGE PROTECTION (OVP) | | | | | | | |
| Overvoltage-Protection, Rising Threshold | OVP | Relative to programmed V_{OUT} | 9.5 | 13 | 16.5 | % | |
| OVP Deglitch Filter Time | | | | 8 | | μs | |
| Power-Good Protection, Falling Threshold | PWRGD | Relative to programmed V_{OUT} | 6 | 9 | 12 | % | |
| Power-Good Protection Rising Threshold | | | 3 | 6 | 9 | % | |
| Power-Good Deglitch Filter Time | | | | | 8 | μs | |
| OVERCURRENT PROTECTION (OCP) | | | | | | | |
| Positive OCP Inception Threshold (Inductor Valley Current) | OCP | Selected by R_SELB or PMBus (Notes 6, 7, 8, 9) | OCP Setting 0 | 16.3 | 21 | 26.1 | A |
| | | | OCP Setting 1 | 20.8 | 27 | 33.0 | |
| | | | OCP Setting 2 | 24.6 | 32 | 39.9 | |
| | | | OCP Setting 3 | 30.6 | 38 | 45.5 | |
| Negative OCP Inception Threshold (Inductor Valley Current) | | Selected by R_SELB or PMBus | OCP Setting 0 | | -28 | | A |
| | | | OCP Setting 1 | | -33 | | |
| | | | OCP Setting 2 | | -39 | | |
| | | | OCP Setting 3 | | -44 | | |
| Hysteresis | | Hysteresis applies only to positive OCP | | 15 | | % | |
| OVERTEMPERATURE PROTECTION (OTP) | | | | | | | |
| OTP Inception Threshold | OTP | Default is 150, 130 is set through PMBus (Notes 7, 8, 9) | 120 | 130 | 140 | $^\circ C$ | |
| | | | 140 | 150 | 160 | | |
| Hysteresis | | | | 10 | | | |
| OE MAXIMUM VOLTAGE | | | | | | | |
| OE Maximum Voltage | OE | Full V_{CC} supply range; measured at the OE pin (Note 6) | $V_{DDH} - 2.5$ | | | V | |
| Rising Threshold | | | 0.83 | 0.9 | 0.97 | | |
| Hysteresis | | | 0.2 | | | | |
| OE Pin Input Resistance | | | 200 | 275 | 350 | | k Ω |
| OE Deglitch Filter Time | | | (Note 9) | | | | 0.9 |
| STARTUP TIMING | | | | | | | |
| Enable Time from OE Rise to Start of BST Charge | t_{OE} | After t_{INIT} | | 16 | | μs | |
| Soft-Start Ramp Time | t_{SS} | 3 or 1.5 can be bet by R_SELA; any value can be set by PMBus (Note 7) | | 0.75 | | ms | |
| | | | | 1.5 | | | |
| | | | | 3 | | | |
| | | | | 6 | | | |
| BST Charging Time | t_{BST} | | | 8 | | μs | |

Electrical Characteristics (continued)

(Circuit of [Figure 6](#), $V_{DDH} = 4.5V$ to $16V$, $T_A = +25^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$. All devices 100% tested at $T_A = +25^\circ C$. Limits over temperature guaranteed by design.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--------------------------------------------------------------------------|-------------------------|---------------------------------------------------------------------------------|------|----------|------|------------|
| STAT PIN | | | | | | |
| Allowable Pullup Voltage | VOH_{STAT} | | | | 3.6 | V |
| Status Output Low | VOL_{STAT} | $I_{STAT} = 2.5mA$ | | | 0.4 | V |
| | | $I_{STAT} = 0.2mA$, $0V < V_{CC} < UVLO$ and $0V < V_{DDH} < UVLO$ (Note 6) | | | 0.65 | |
| | | $I_{STAT} = 1.3mA$, $0V < V_{CC} < UVLO$ and $0V < V_{DDH} < UVLO$ (Note 6) | | | 0.75 | |
| Status Output High Leakage Current | I_{STAT} | STAT pulled up to 3.3V through 20k Ω (Note 6) | | | 7 | μA |
| Time from V_{OUT} Ramp Completion to STAT Pin Released | t_{STAT} | STAT output low to high, default is 125; 2000 can be set through PMBus (Note 7) | | 125 | | μs |
| | | | | 2000 | | |
| PGMA AND PGMB PINS (see Tables 2–5) | | | | | | |
| Allowable R_SEL Resistor Range | | 12 resistor values detected | 1.78 | | 162 | k Ω |
| R_SEL Resistor Required Accuracy | | EIA standard resistor values only | | ± 1 | | % |
| Allowable C_SEL Capacitor Range | | 3 options (0pF, 220pF, or 1000pF) | 0 | | 1000 | pF |
| C_SEL Capacitor Required Accuracy | | Use X7R or better | | ± 20 | | % |
| Allowable External Capacitance | | Load and stray capacitance in addition to C_SELA/B | | | 20 | pF |
| PMBus TELEMETRY | | | | | | |
| Reading Range | V_{DDH} Readback | | 4.5 | | 16 | V |
| Reading Update Interval | | | | 5 | | ms |
| Reading Averaging Interval | | | | 1 | | ms |
| Reading Error | | $T_A = -40^\circ C$ to $T_J = +125^\circ C$ (Notes 8, 9, 10, 11) | -3 | | +3 | % |
| Reading Resolution | | | | 28 | | mV |
| Reading Range | V_{SENSE} Readback | | 0 | | 1.25 | V |
| Reading Update Interval | | | | 5 | | ms |
| Reading Averaging Interval | | | | 1 | | ms |
| Referred to SENSE Pins (V_{OUT} may be scaled by divider in feedback) | | $T_A = -40^\circ C$ to $T_J = +125^\circ C$ (Notes 8, 9, 10, 11) | -25 | | +25 | mV |
| Reading Resolution | | | | 1.95 | | mV |
| Reading Range | I_{OUT} Readback | | 0 | | 25 | A |
| Reading Update Interval | | | | 5 | | ms |
| Reading Averaging Interval | | | | 1 | | ms |
| Reading Error | | $T_A = -40^\circ C$ to $T_J = +125^\circ C$ (Notes 8, 9, 10, 11) | | ± 3 | | A |
| Reading Resolution | | | | 0.07 | | A |

Electrical Characteristics (continued)

(Circuit of [Figure 6](#), $V_{DDH} = 4.5V$ to $16V$, $T_A = +25^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$. All devices 100% tested at $T_A = +25^\circ C$. Limits over temperature guaranteed by design.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | |
|----------------------------------------------------|-------------------------|-------------------------|------|-----------|---------|------------|------------|
| Reading Range | Temperature Readback | | -40 | | +125 | $^\circ C$ | |
| Reading Update Interval | | | | 5 | | ms | |
| Reading Averaging Interval | | | | | 1 | | ms |
| Reading Error | | (Notes 6, 8, 9) | | | ± 8 | | $^\circ C$ |
| Reading Resolution | | | | | 0.52 | | $^\circ C$ |
| PMBus PINS (CLK, DATA, SMALERT) | | | | | | | |
| Input Rising Threshold | V_{T_RISE} | | 0.83 | 0.9 | 0.97 | V | |
| Input Falling Threshold | V_{T_FALL} | | 0.62 | 0.7 | 0.79 | V | |
| Hysteresis | V_{HYS} | | | 0.2 | | V | |
| Output Low Voltage | V_{OL} | Sinking 4mA | | | 0.4 | V | |
| PMBus Clock Frequency | f_{PM_CLK} | | | | 400 | kHz | |
| SYSTEM SPECIFICATIONS (Note 10) | | | | | | | |
| Line Regulation | V_{OUT} | | | ± 0.2 | | % | |
| Load Regulation (Static) | | $I_{OUT} = 0 - I_{MAX}$ | | ± 0.7 | | | |
| Efficiency ($V_{DDH} = 12V$, $V_{OUT} = 1V$) | η | Peak | | 90.7 | | % | |
| | | Full load (40A) | | 84.3 | | | |

Note 5: For proper regulation, it is required that $V_{DDH} > (V_{OUT} + 2V)$. If V_{OUT} is set $> (UVLO - 2V)$, the IC may come out of UVLO, but regulation is not guaranteed while V_{DDH} is below $(V_{OUT} + 2V)$. To avoid this condition, OE can be held low until $V_{DDH} > (V_{OUT} + 2V)$.

Note 6: Denotes specifications that apply over the temperature range of $T_J = -40$ to $+125^\circ C$.

Note 7: Denotes parameters that are programmable.

Note 8: Min/Max limits are $\geq 4\sigma$ about the mean.

Note 9: Guaranteed by design; not production tested.

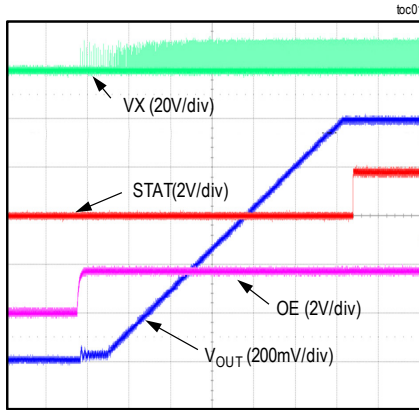
Note 10: These specifications refer to the operation of the system and are based on the circuit shown in the reference schematic. Tolerance of external components may affect these parameters. System performance numbers are measured using the Maxim evaluation board for this product with BOM, as shown on the MAX20734 EV kit data sheet. If a different PCB layout and different external components are used, these values may change.

Note 11: A $-40^\circ C$ test condition is specified at a T_A test condition, instead of T_J , to allow for self-heating.

Typical Operating Characteristics

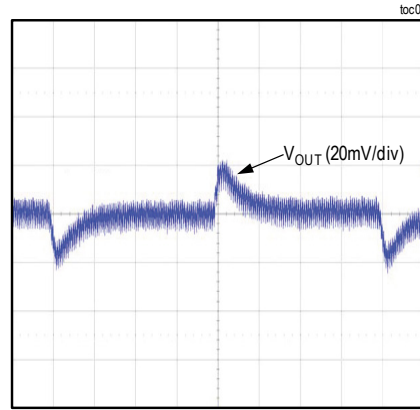
(Unless otherwise stated: Tested on the MAX20734EVKIT# EV kit with component values per [Table 7](#), $V_{DDH} = 12V$, $V_{OUT} = 1V$, $f_{SW} = 400kHz$, $T_A = 25^{\circ}C$, Still Air, and No Heatsink.)

STARTUP RESPONSE



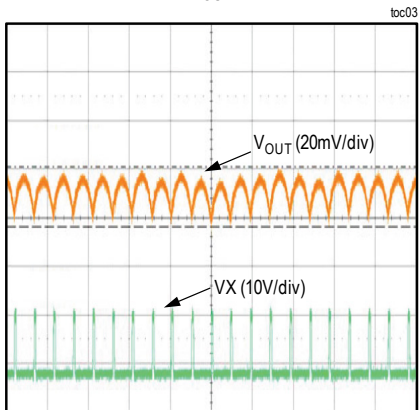
TIME: 500μs/div

TRANSIENT RESPONSE



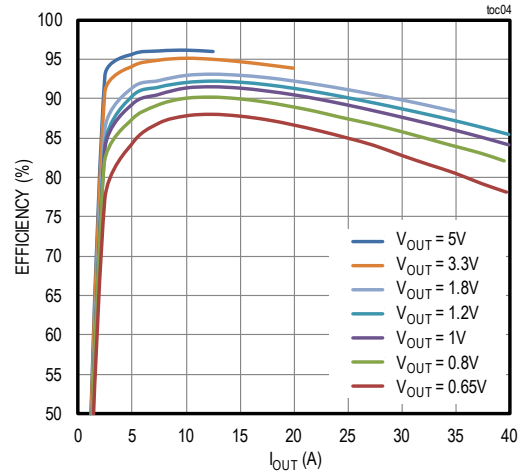
TIME: 50μs/div
CONDITIONS: $I_{OUT} = 20A$ to $30A$ STEP at $1A/\mu s$

TYPICAL V_{OUT} RIPPLE



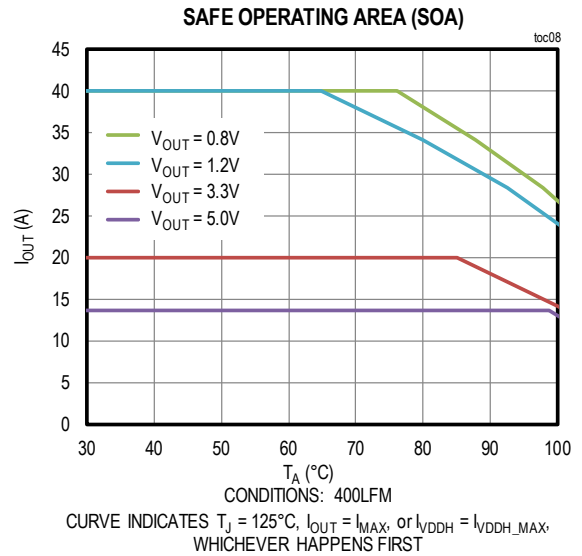
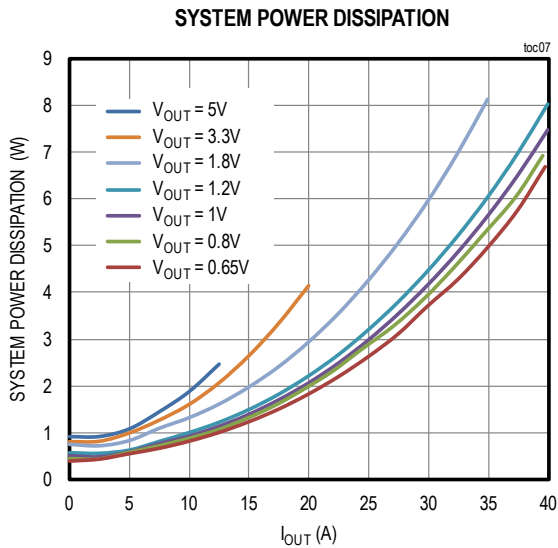
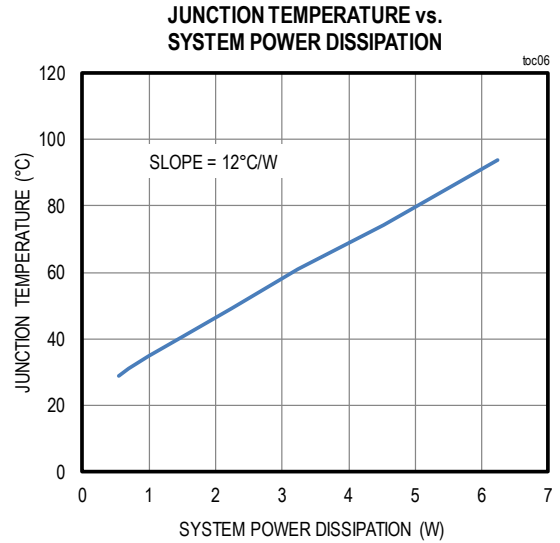
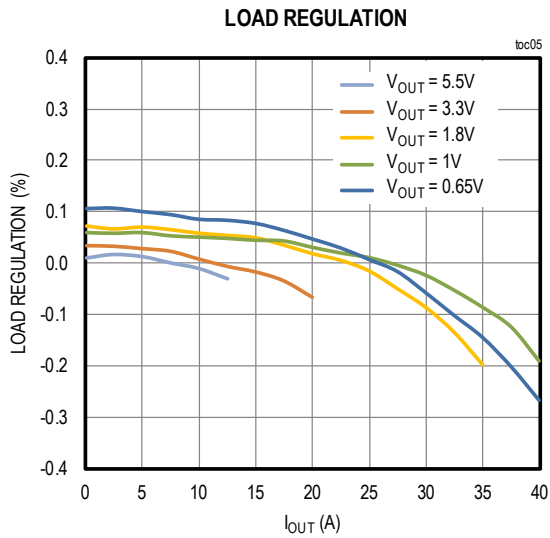
TIME: 5μs/div
CONDITIONS: $I_{OUT} = 40A$

SYSTEM EFFICIENCY vs. OUTPUT LOAD



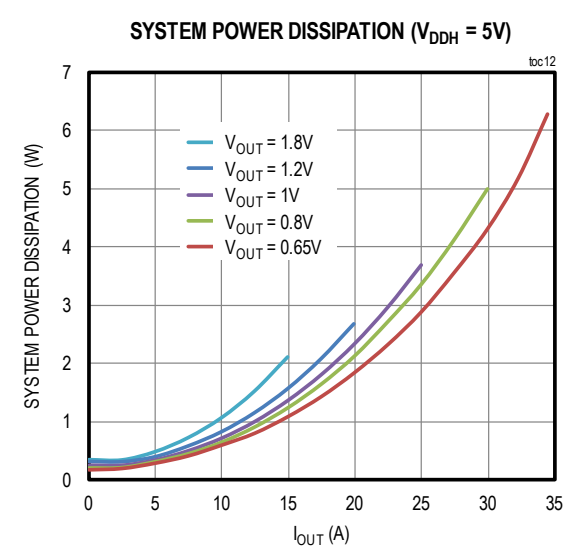
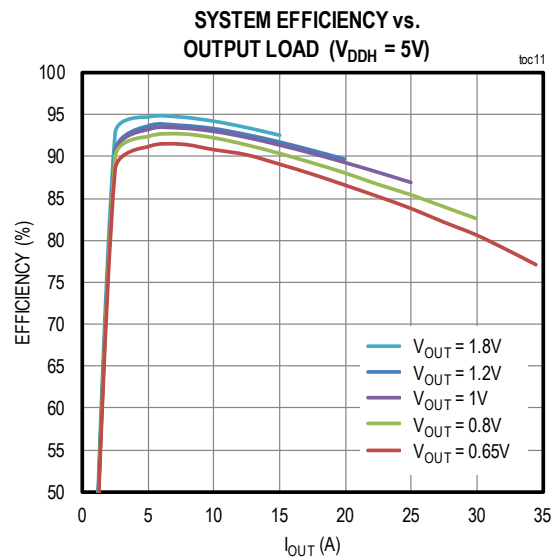
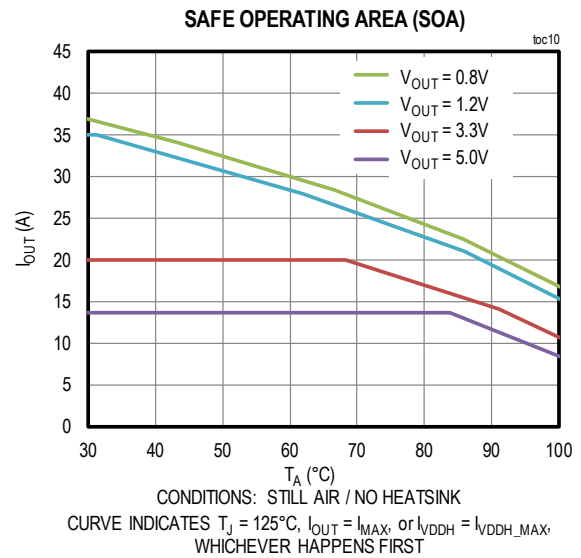
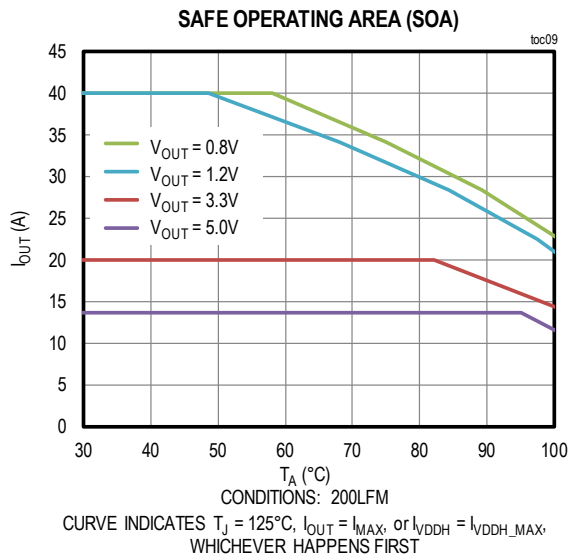
Typical Operating Characteristics (continued)

(Unless otherwise stated: Tested on the MAX20734EVKIT# EV kit with component values per Table 7, $V_{DDH} = 12V$, $V_{OUT} = 1V$, $f_{SW} = 400kHz$, $T_A = 25^\circ C$, Still Air, and No Heatsink.)



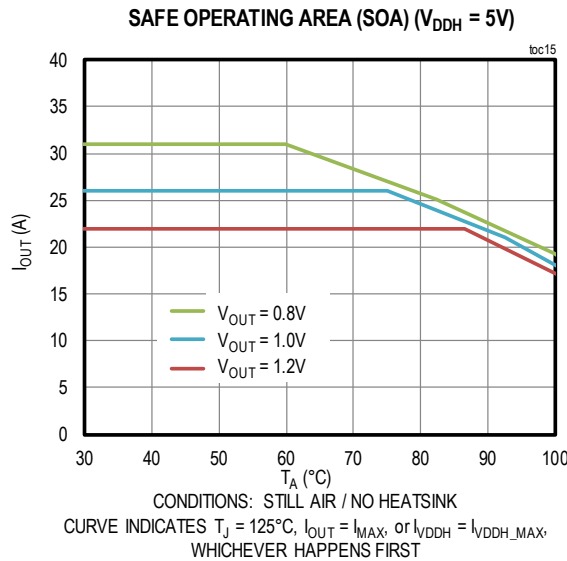
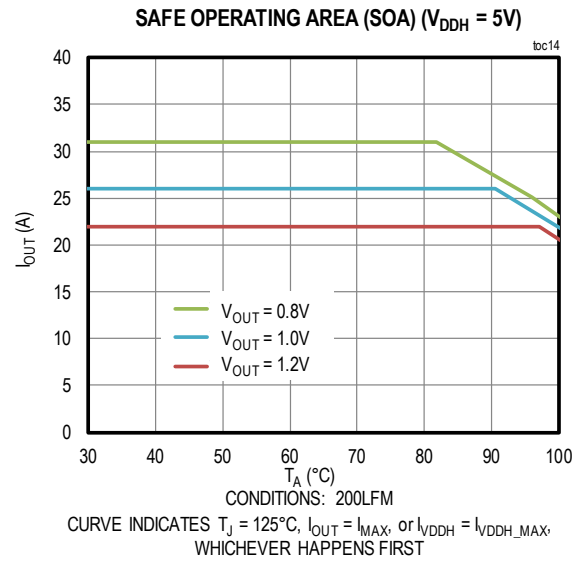
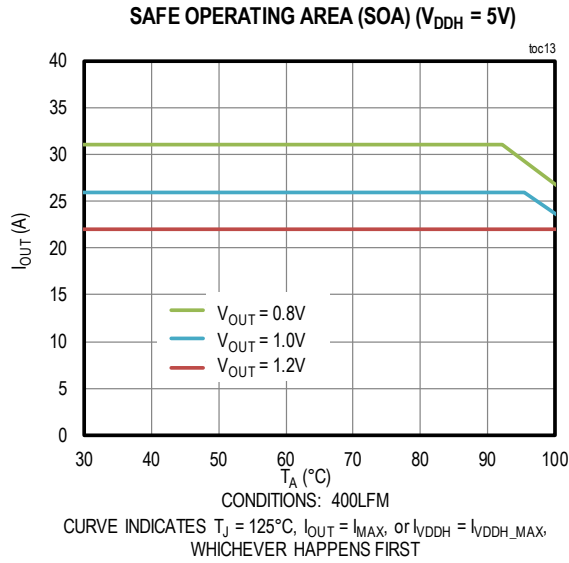
Typical Operating Characteristics (continued)

(Unless otherwise stated: Tested on the MAX20734EVKIT# EV kit with component values per Table 7, $V_{DDH} = 12V$, $V_{OUT} = 1V$, $f_{SW} = 400kHz$, $T_A = 25^\circ C$, Still Air, and No Heatsink.)

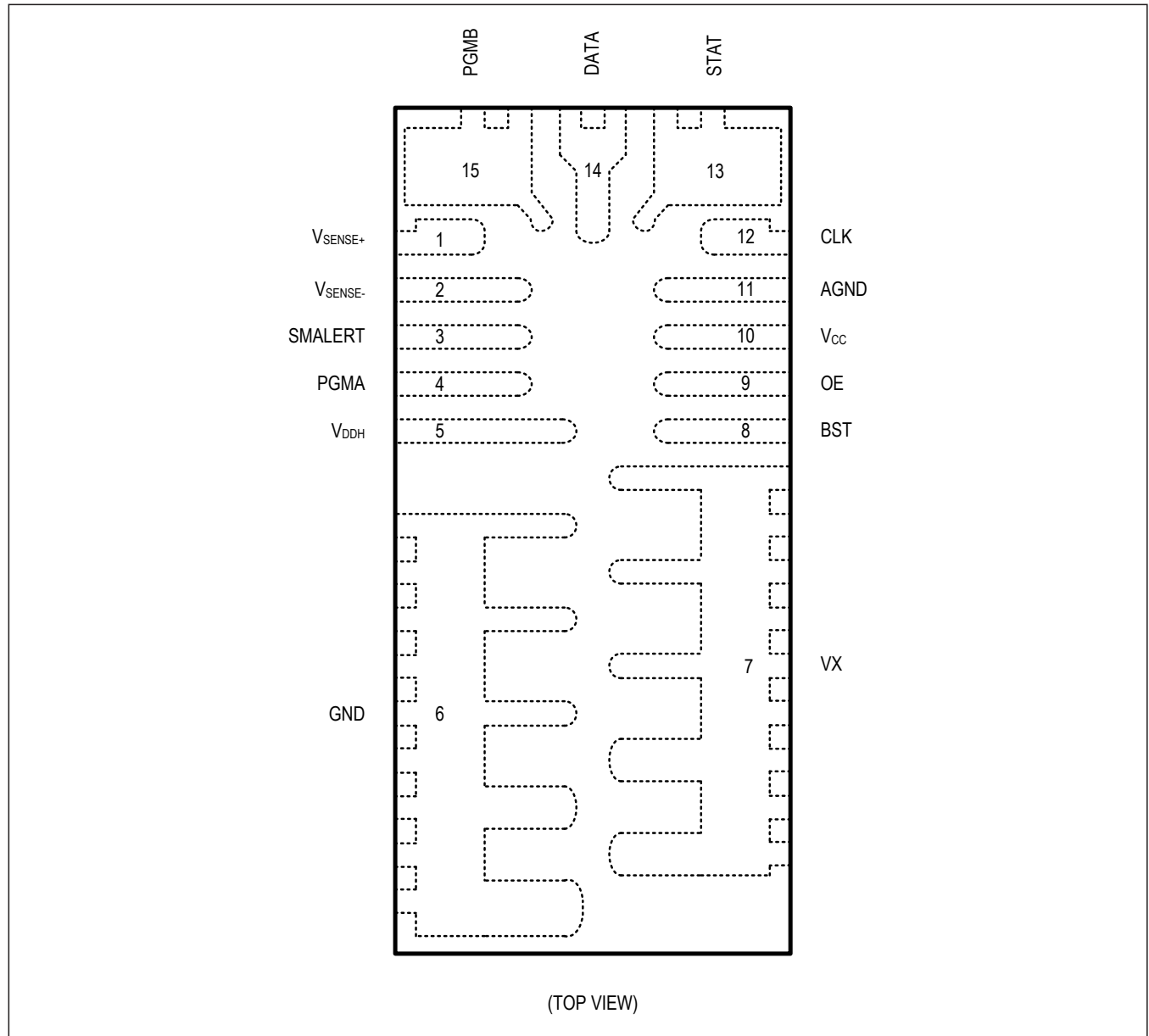


Typical Operating Characteristics (continued)

(Unless otherwise stated: Tested on the MAX20734EVKIT# EV kit with component values per Table 7, $V_{DDH} = 12V$, $V_{OUT} = 1V$, $f_{SW} = 400kHz$, $T_A = 25^\circ C$, Still Air, and No Heatsink.)



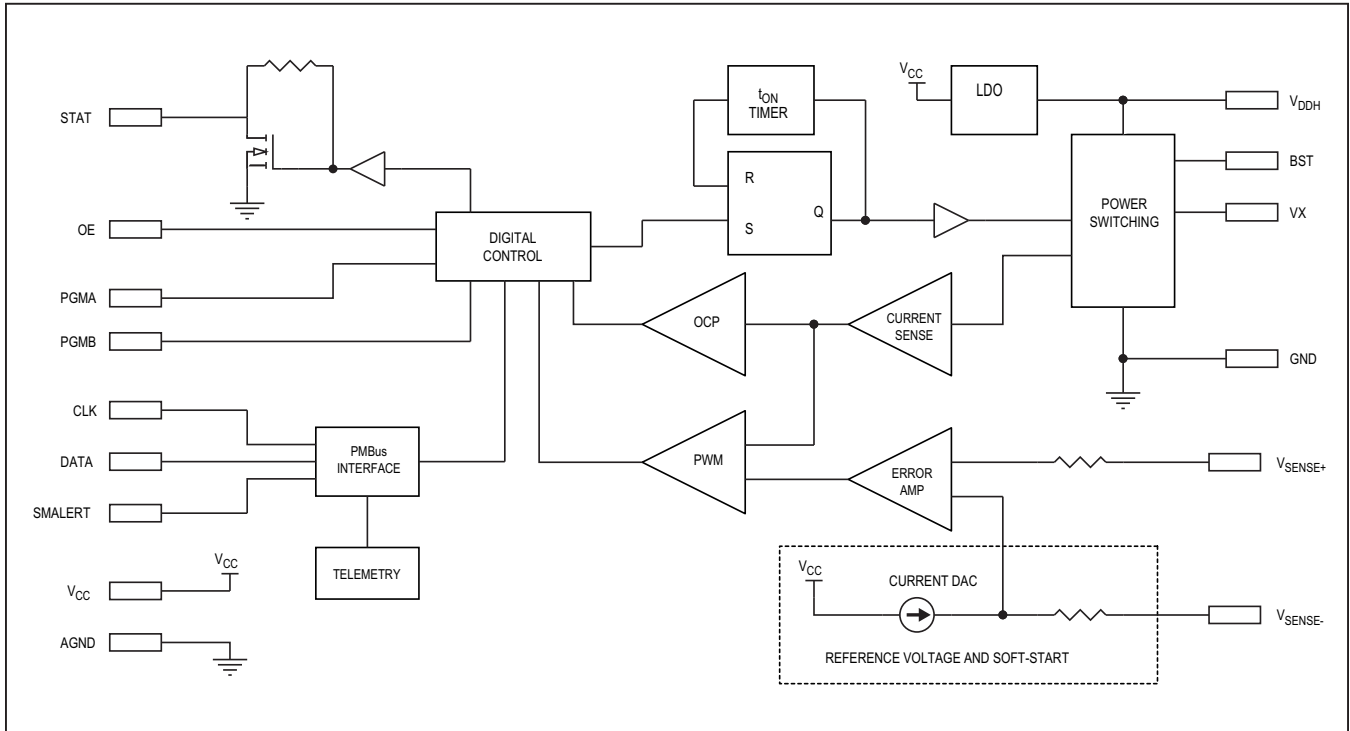
Pin Configuration



Pin Description

| PIN | NAME | FUNCTION |
|-----|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1 | V _{SENSE+} | Remote-Sense Positive Node. Connect this node to V _{OUT} at the load. A resistive voltage-divider can be used to regulate the output above the reference voltage. |
| 2 | V _{SENSE-} | Remote-Sense Negative Node. Connect this node to ground at the load using a Kelvin connection. |
| 3 | SMALERT | SMALERT Pin |
| 4 | PGMA | Program Node. Connect this node to ground through a programming resistor and capacitor. |
| 5 | V _{DDH} | Power Input Voltage. The high-side MOSFET switch is connected to this node. See the <i>Input Capacitor Selection</i> section for decoupling requirements. |
| 6 | GND | Power Ground Node. The low-side MOSFET switch is connected to this node. |
| 7 | VX | Power Switching Node. Connect this node to the inductor. |
| 8 | BST | Bootstrap for High-Side Switch. Connect a 0.22μF ceramic capacitor between BST and VX. |
| 9 | OE | Output Enable Node. This node is used to enable the regulator and has a precise threshold to allow sequencing of multiple regulators. There is an internal 275kΩ (typ) pulldown on this node. |
| 10 | V _{CC} | Analog/Gate-Drive Supply for the IC from Internal 1.85V (typ) LDO. This node must be connected to three 10μF X5R or better decoupling capacitors with very short, wide traces. V _{CC} can be connected to 20kΩ pullups for STAT and OE, as shown in Figure 6. Do not connect V _{CC} to other external loads. Do not overdrive V _{CC} from an external source. |
| 11 | AGND | Analog/Signal Ground. See the <i>PCB Layout</i> section for layout information. |
| 12 | CLK | PMBus Clock |
| 13 | STAT | Open-Drain Power-Good/Fault-Status Indication. Connect a pullup resistor to 1.8V or 3.3V. |
| 14 | DATA | PMBus Data |
| 15 | PGMB | Program Node. Connect this node to ground through a programming resistor and capacitor. |

Block Diagram



Operation

Control Architecture

The MAX20734 provides an extremely compact, high-efficiency regulator solution with minimal external components and circuit design required. The monolithic solution includes the top and bottom power switches, gate drives, precision DAC reference, PWM controller, fault protections, and PMBus interface (see the [Block Diagram](#)). An external bootstrap capacitor is used to provide the drive voltage for the top switch. Other external components include the input and output filter capacitors, buck inductor, and a few resistors and capacitors to set the operating mode.

The IC implements an advanced valley current-mode control algorithm that supports all multi-layer ceramic chip (MLCC) output capacitors and fast transient response. In steady state, it operates at a fixed switching frequency. When loading transients, the switching frequency speeds up to minimize the output voltage undershoot. Likewise, when unloading transients, the switching frequency slows down to minimize the output voltage overshoot.

The switching frequency can be set to 400kHz, 600kHz, or 800kHz through C_SELB and can be overridden through PMBus to 400kHz, 500kHz, 600kHz, 700kHz, 800kHz, or 900kHz.

Voltage regulation is achieved by modulating the low-side on-time, comparing the difference between the feedback and reference voltages with the low-side current-sense signal using Maxim’s proprietary integrated current-sense technology. Once the PWM modulator forces a low-to-high transition, the high-side switch is enabled for a fixed time, after which the low-side switch is turned on again. An error amplifier with an integrator is used to maintain zero-droop operation. The integrator has a transient recovery time constant of 20µs (typ).

During regulation, the differential voltage between the VSENSE+ and VSENSE- pins tracks the reference voltage, which is set by the DAC and can be set from 0.6016V to 1V. The sense pins can be connected to the output voltage through a voltage-divider so V_{OUT} can be higher than 1V.

The switching frequency is determined by the high-side on-time, as shown in Equation 1.

Equation 1:

$$f_{SW} = \frac{1}{t_{H_ON}} \times \frac{V_{OUT}}{V_{DDH}}$$

where:

f_{SW} = Switching frequency (MHz)

t_{H_ON} = On-period for high-side switch (μ s)

V_{OUT} = Output voltage (V)

V_{DDH} = Input voltage (V)

The t_{H_ON} high-side on-time is controlled by the IC to be proportional to the duty cycle so that the resulting switching frequency is independent of supply voltage and output voltage.

Equation 2:

$$t_{H_ON} \propto \frac{V_{OUT}}{V_{DDH}}$$

The t_{H_ON} pulse width is clamped to a minimum of 50ns (after t_{SS}) and a maximum of 2 μ s to prevent any unexpected operation during extreme V_{OUT} conditions.

Voltage-Regulator Enable and Turn-On Sequencing

The startup timing is shown in [Figure 1](#). After V_{DDH} is applied, the IC goes through an initialization time (t_{INIT}) that takes up to 308 μ s. After initialization, OE is read. Once OE is high for more than the 16 μ s OE filter time (t_{OE}), BST charging starts and is performed for 8 μ s (t_{BST}), and then the soft-start ramp begins. The soft-start ramp time (t_{SS}) can be 0.75ms, 1.5ms, 3ms, or 6ms depending on the user's programmed value. V_{OUT} ramps up linearly during the soft-start ramp time. If there are no faults, the STAT pin is released from being held low after the

completion of the soft-start ramp time plus the user-programmable STAT blanking time (t_{STAT}) of 125 μ s or 2ms. If OE is pulled low, the IC shuts down.

Alternatively, the IC can be enabled by sending a PMBus Operate command. This raises the internal Operation signal, which is OR'd with the OE pin to create an internal OE signal. Therefore, when either the OE pin or the internal Operate signal go high, startup is initiated, but it takes both to be low to shut the part down.

Soft-Start Control

The initial output voltage behavior is determined by a linear ramp of the internal reference voltage from zero to the final value (t_{SS} in [Figure 1](#)). The ramp time (t_{SS}) is programmable from 0.75ms to 6ms.

If the regulator is enabled when the output voltage has a residual voltage, the system will not regulate until the reference voltage ramps above this residual value. In this case, the t_{OE} (OE valid to onset of regulation) specification is extended by the time required for the desired voltage start-up ramp to reach the actual residual output voltage, but the time to reach the steady-state output voltage is unchanged.

If the residual voltage is higher than the set output voltage, neither the high-side or low-side switch is turned on by the end of t_{SS} . Under these conditions, switching begins after t_{SS} .

The MAX20734 exhibits a non-linearity during startup. This behavior is normal and does not have an adverse effect on system operation. With the circuit of [Figure 6](#), the typical nonlinearity is 55mV with $R_{GAIN} = 0.8mV/A$ or 1.6mV/A, 330mV with $R_{GAIN} = 3.2mV/A$, and 480mV with $R_{GAIN} = 6.4mV/A$. The nonlinearity gets proportionately smaller as C_{OUT} increases.

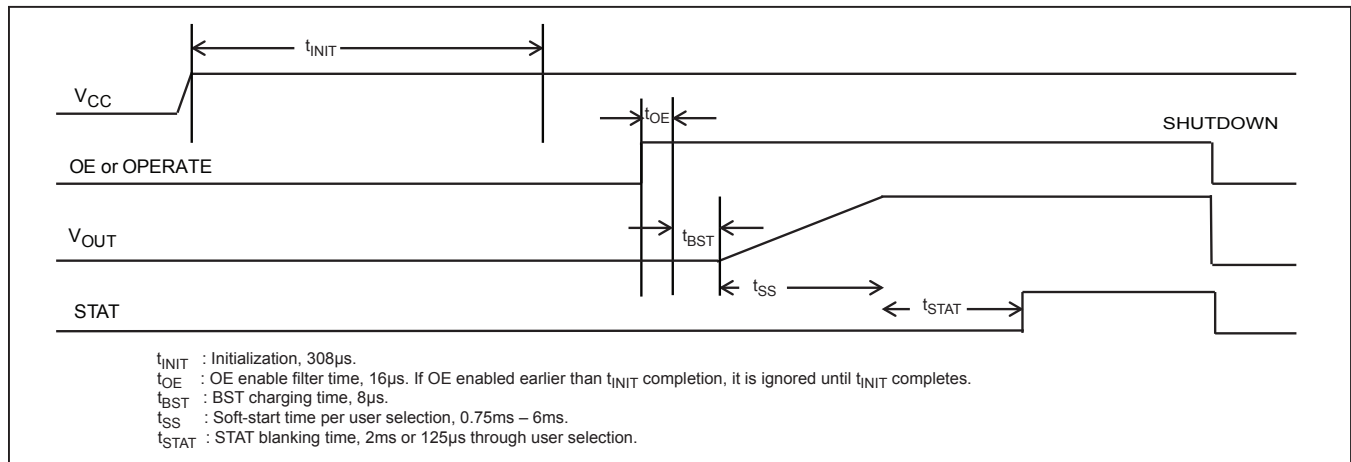


Figure 1. Startup Timing

Remote Output-Voltage Sensing

To ensure the most accurate sensing of the output voltage, a differential voltage-sense topology is used, with a negative remote-sense pin provided. Point-of-load (PoL) sensing compensates for voltage drops between the output of the regulator and its load and provides the highest regulation accuracy. The voltage-sensing circuit features excellent common-mode rejection to further improve load voltage regulation.

Protection and Status Operation

Output-Voltage Protection

The feedback voltage is continuously monitored for both undervoltage and overvoltage conditions. The typical fault-detection threshold is 13% above and 9% below the reference voltage (see the [Electrical Characteristics](#) table). If the output voltage falls below the power-good protection (PWRGD) threshold beyond the filter time, the STAT output goes low, but the system continues to operate, attempting to maintain regulation.

If the output voltage rises above the overvoltage protection (OVP) threshold beyond the filter time, the STAT pin is lowered and the system shuts down until the output voltage falls within the valid range.

Current Limiting and Short-Circuit Protection

The regulator’s valley current-mode control architecture provides inherent current limiting and short-circuit protection. The bottom switch’s instantaneous current is monitored using integrated current sensing and is controlled on a cycle-by-cycle basis within the control block.

Current clamping occurs when the minimum instantaneous (“valley”) low-side switch current level exceeds

the OCP threshold current, as shown in [Figure 2](#). In this situation, turn-on of the high-side switch is prevented until the current falls below the threshold level. Since the inductor valley current is the controlled parameter, the average current delivered during positive current clamping remains a function of several system-level parameters. Note that I_{OCP} has hysteresis and the value drops down to I_{OCP2} once it has been triggered (see [Figure 2](#)).

Undervoltage Lockout (UVLO)

The regulator internally monitors V_{DDH} with a UVLO circuit. When the input supply voltage is below the UVLO threshold, the regulator stops switching, and the STAT pin is driven low. For UVLO levels, see the [Electrical Characteristics](#) table.

Overtemperature Protection (OTP)

The OTP-level default is 150°C and can be set to 130°C over PMBus. If the die temperature reaches the OTP level during operation, the regulator is disabled and the STAT pin is driven low. Overtemperature is a nonlatching fault, with the hysteresis shown in the [Electrical Characteristics](#) table.

Table 1. Summary of Fault Actions

| FAULT | ACTION |
|---------------------------------------------------|--------------------------------|
| Power Good (Output Undervoltage) | STAT LOW |
| Output OVP | STAT LOW, Shutdown and Restart |
| Overtemperature | STAT LOW, Shutdown and Restart |
| Supply Fault (V_{DDH} , UVLO, V_{CC_UVLO}) | STAT LOW, Shutdown and Restart |
| BST Fault | STAT LOW, Shutdown and Restart |

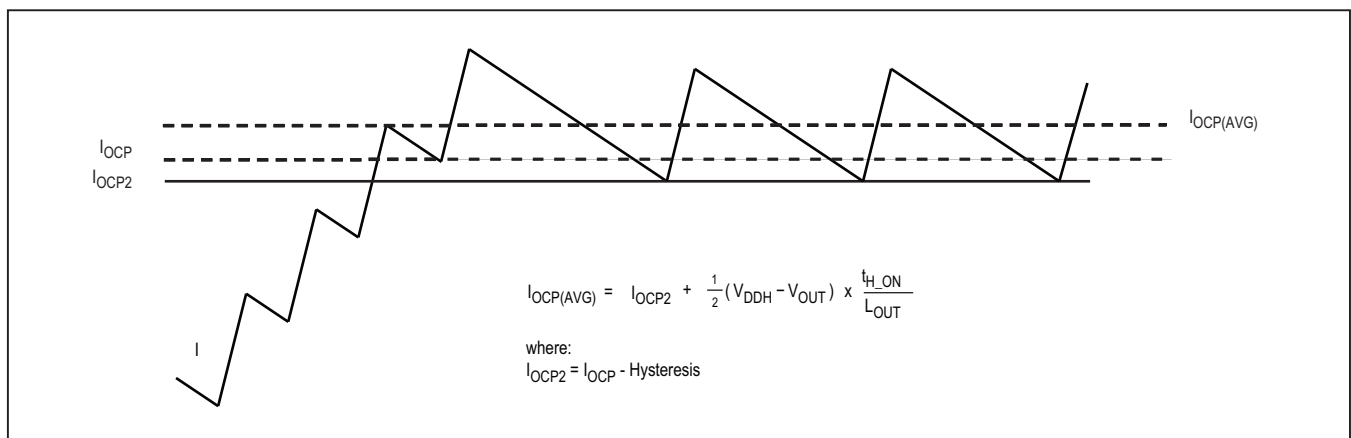


Figure 2. Inductor Current During Current Limiting

Regulator Status (STAT)

The STAT signal provides an open-drain output consistent with CMOS logic levels, which indicates whether the regulator is functioning properly. An external pullup resistor is required for connecting STAT to V_{CC} or another 1.8V or 3.3V supply.

The STAT pin is low while the regulator is disabled and goes high after the startup ramp is completed, plus the programmed t_{STAT} blanking interval if the output voltage is within the PWRGD/OVP regulation window. The STAT pin is an open-drain output and is 3.3V tolerant. The pin remains low when V_{DDH} is not present.

The STAT pin is driven low when one or more of the following conditions occurs:

- PWRGD fault (see the [Output-Voltage Protection](#) section)
- V_{SENSE-} pin is left unconnected or shorted to V_{DDH}
- Die temperature exceeds the temperature shutdown threshold shown in the [Electrical Characteristics](#) table
- OVP circuit detects that the output voltage is above the tolerance limit
- Supply voltage drops below the UVLO threshold
- Fault detected on the BST node, such as shorted or open bootstrap capacitor

The ensuing startup follows the same timing shown in [Figure 1](#).

Table 2. PGMA Pin R_SELA Values

| NO. | R (k Ω) $\pm 1\%$ | SOFT-START TIME (mS) | PMBus SLAVE ADDRESS (1010_xxx) |
|-----|---------------------------|----------------------|--------------------------------|
| 1 | 1.78 | 3 | 1010 000b |
| 2 | 2.67 | 3 | 1010 001b |
| 3 | 4.02 | 3 | 1010 010b |
| 4 | 6.04 | 3 | 1010 011b |
| 5 | 9.09 | 3 | 1010 100b |
| 6 | 13.3 | 3 | 1010 101b |
| 7 | 20 | 3 | 1010 110b |
| 8 | 30.9 | 3 | 1010 111b |
| 9 | 46.4 | 1.5 | 1010 000b |
| 10 | 71.5 | 1.5 | 1010 001b |
| 11 | 107 | 1.5 | 1010 010b |
| 12 | 162 | 1.5 | 1010 011b |

PGMA and PGMB Pin Functionality

The PGMA and PGMB pins are used to set up some of the key programmable features of the regulator IC. A resistor and capacitor are connected to the PGMA/B pins and their values are read during power-up initialization (e.g., power must be cycled to re-read the values).

The parasitic loading on the PGMA and PGMB pins must be limited to less than 20pF and greater than 20m Ω to avoid interfering with the R_SEL and C_SEL decoding.

Table 3. PGMA Pin C_SELA Capacitor Values

| NO. | C (pF) $\pm 20\%$ | V_{BOOT} (V) |
|-----|-------------------|----------------|
| 1 | Open | 0.6484 |
| 2 | 220 | 0.8984 |
| 3 | 1000 | 1 |

Table 4. PGMB Pin R_SELB Values

| NO. | R (k Ω) $\pm 1\%$ | R _{GAIN} (m Ω) | OCP SETTING* |
|-----|---------------------------|---------------------------------|--------------|
| 1 | 1.78 | 0.8 | 0 |
| 2 | 2.67 | 0.8 | 1 |
| 3 | 4.02 | 0.8 | 2 |
| 4 | 6.04 | 0.8 | 3 |
| 5 | 9.09 | 3.2 | 0 |
| 6 | 13.3 | 3.2 | 1 |
| 7 | 20 | 3.2 | 2 |
| 8 | 30.9 | 3.2 | 3 |
| 9 | 46.4 | 1.6 | 0 |
| 10 | 71.5 | 1.6 | 1 |
| 11 | 107 | 1.6 | 2 |
| 12 | 162 | 1.6 | 3 |

*See the [Electrical Characteristics](#) table for values.

Table 5. PGMB Pin C_SELB Capacitor Values

| NO. | C (pF) $\pm 20\%$ | f_{SW} FREQUENCY (kHz) |
|-----|-------------------|--------------------------|
| 1 | Open | 400 |
| 2 | 220 | 600 |
| 3 | 1000 | 800 |

PMBus Commands

A summary of PMBus commands is shown in [Table 6](#). PMBus communication can be initiated as soon as V_{CC} is valid (after t_{INIT} , [Figure 1](#)), regardless of the state of the OE and STAT pins. For more information, refer to AN6209: *MAX20734 PMBus Application Note*.

Table 6. Summary of PMBus Commands

| COMMAND CODE | COMMAND NAME | TYPE* | NO. OF DATA BYTES |
|--------------|---------------|-------|-------------------|
| 01h | OPERATION | RW | 1 |
| 02h | ON_OFF_CONFIG | RO | 1 |
| 03h | CLEAR_FAULTS | WO | 0 |
| 10h | WRITE_PROTECT | RW | 1 |
| 1Bh | PMBALERT_MASK | RW | 2 |
| 20h | VOUT_MODE | RO | 1 |
| 21h | VOUT_COMMAND | RW | 2 |
| 24h | VOUT_MAX | RW | 2 |
| 78h | STATUS_BYTE | RO | 1 |
| 79h | STATUS_WORD | RO | 2 |
| 7Ah | STATUS_VOUT | RO | 1 |
| 7Bh | STATUS_IOUT | RO | 1 |
| 7Ch | STATUS_INPUT | RO | 1 |

PMBus Telemetry

The IC provides input and output voltage, output current, and junction-temperature telemetry. Output voltage is measured at the $V_{SENSE+/-}$ pins. Therefore, if there is a divider in the feedback, the measurement is scaled by the divide ratio. For range and accuracy specifications, see the [Electrical Characteristics](#) table. For data format, refer to AN6209: *MAX20734 PMBus Application Note*.

| COMMAND CODE | COMMAND NAME | TYPE* | NO. OF DATA BYTES |
|--------------|---------------------|-------|-------------------|
| 7Dh | STATUS_TEMPERATURE | RO | 1 |
| 7Eh | STATUS_CML | RO | 1 |
| 80h | STATUS_MFR_SPECIFIC | RO | 1 |
| 88h | READ_VIN | RO | 2 |
| 8Bh | READ_VOUT | RO | 2 |
| 8Ch | READ_IOUT | RO | 2 |
| 8Dh | READ_TEMPERATURE_1 | RO | 2 |
| 99h | MFR_ID | BLK | 4 |
| 9Bh | MFR_REVISION | BLK | 1 |
| D1h | MFR_VOUT_MIN | RW | 2 |
| D2h | MFR_DEVSET1 | RW | 2 |
| D3h | MFR_DEVSET2 | RW | 2 |

*RW = Read/Write, WO = Write Only, RO = Read Only, and BLK = Block.

Reference Design

A typical application schematic is shown in [Figure 3](#), and optimum component values for common output voltages are shown in [Table 7](#).

Output-Voltage Setting

If an output voltage not listed in [Table 7](#) is required, calculate new values for R_{FB1} and R_{FB2} (as discussed below) and use the other circuit values of the closest output voltage in [Table 7](#), or calculate them as shown below.

Average Input Current Limit

The input current of V_{DDH} is given by Equation 3. V_{OUT}, I_{OUT}, and V_{DDH} should be properly chosen so that the average input current does not exceed 6A (I_{VDDH_MAX}).

Equation 3:

where:

$$I_{VDDH} = \frac{V_{OUT} \times I_{OUT}}{V_{DDH} \times \eta}$$

V_{OUT} = Output voltage

I_{OUT} = Output current

V_{DDH} = Input voltage

η = Efficiency (refer to the [Typical Operating Characteristics](#) section)

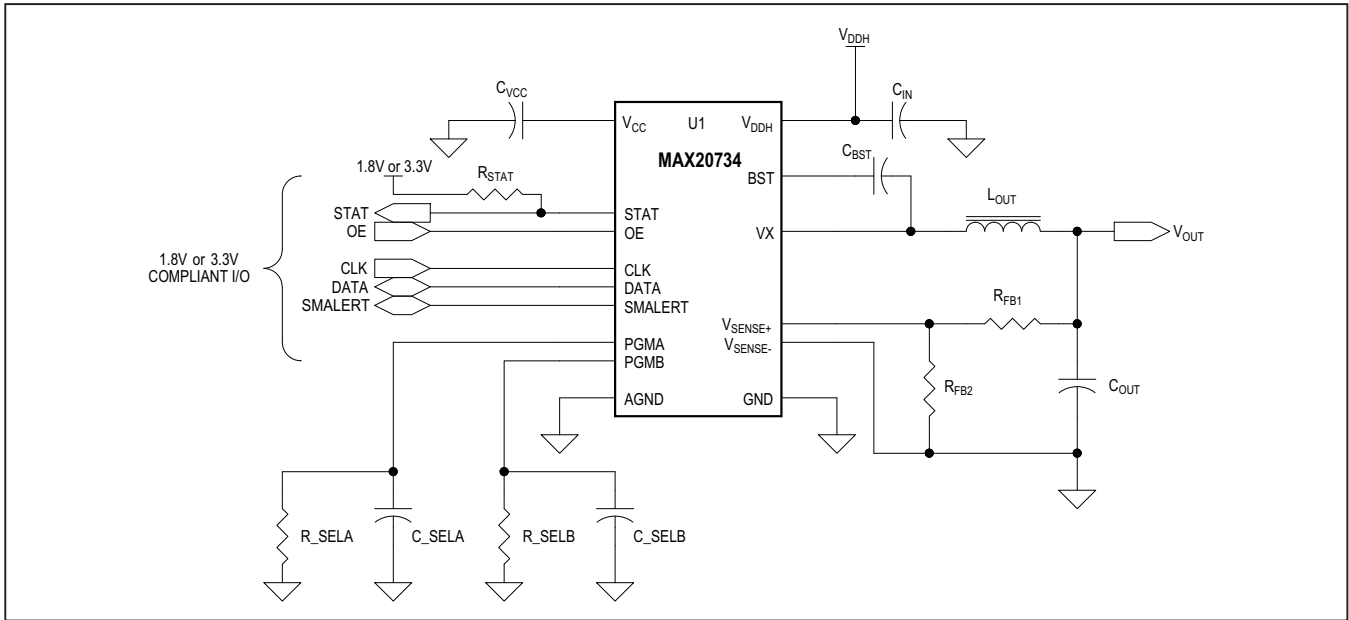


Figure 3. Typical Application Circuit

Table 7. Reference Design Component Values

| V _{OUT} (V) | R _{FB1} (kΩ) | R _{FB2} (kΩ) | R _{SELA} (kΩ) | C _{SELA} (pF) | R _{SELB} (kΩ) | C _{SELB} (pF) | R _{GAIN} (mΩ) | V _{REF} (V) | f _{sw} (kHz) | L _{OUT} (nH) | C _{OUT} |
|----------------------|-----------------------|-----------------------|------------------------|------------------------|------------------------|------------------------|------------------------|----------------------|-----------------------|-----------------------|-----------------------|
| 0.6484 | 1 | Open | 1.78 | Open | 107 | Open | 1.6 | 0.6484 | 400 | 170 | 12 x 100μF + 1 x 22μF |
| 0.8 | 1.37 | 5.9 | 1.78 | Open | 71.5 | Open | 1.6 | 0.6484 | 400 | 170 | 10 x 100μF + 1 x 22μF |
| 1 | 1.87 | 3.48 | 1.78 | Open | 71.5 | Open | 1.6 | 0.6484 | 400 | 170 | 9 x 100μF + 1 x 22μF |
| 1.2 | 1.74 | 2.05 | 1.78 | Open | 71.5 | Open | 1.6 | 0.6484 | 400 | 170 | 9 x 100μF + 1 x 22μF |
| 1.8 | 3.09 | 1.74 | 1.78 | Open | 71.5 | 220 | 1.6 | 0.6484 | 600 | 170 | 9 x 100μF + 1 x 22μF |
| 3.3 | 5.62 | 1.37 | 1.78 | Open | 162 | 220 | 1.6 | 0.6484 | 600 | 210 | 9 x 100μF + 1 x 22μF |
| 5.0 | 7.15 | 1.07 | 1.78 | Open | 107 | 220 | 1.6 | 0.6484 | 600 | 210 | 9 x 100μF + 1 x 22μF |

Note: For input caps, see the [Input Capacitor Selection](#) section.

The output voltage is set by the V_{REF} DAC and divider ratio of resistors R_{FB1} and R_{FB2} per Equation 4. The IC regulates the V_{SENSE+} pin to the reference voltage (V_{REF}) set by the DAC. Upon power-up, the DAC voltage initializes to one of the user-selectable V_{BOOT} voltages. Using PMBus, the DAC can also be set to any voltage from 0.6016V to 1V with 3.9mV resolution, as shown in Table 8. The divider resistors are chosen to give the correct output voltage and to have an approximate parallel resistance of $R_{PAR} = 1k\Omega$ for best common-mode rejection of the error amplifier. In applications requiring less than 10mV peak-to-peak output voltage ripple, setting a lower DAC reference voltage such as 0.6484V or less is recommended because the part will have less DAC voltage noise.

Equation 4:

$$V_{OUT} = V_{REF} \times \left(1 + \frac{R_{FB1}}{R_{FB2}} \right)$$

where $V_{REF} = 0.6016V$ to $1V$ (set by DAC).

Table 8. Voltage vs. PMBus VOUT_COMMAND

| VOUT COMMAND [9:0] (decimal) | VOLTAGE (V) | ACCURACY (+/-) | VOUT COMMAND [9:0] (decimal) | VOLTAGE (V) | ACCURACY (+/-) | VOUT COMMAND [9:0] (decimal) | VOLTAGE (V) | ACCURACY (+/-) |
|------------------------------|-------------|----------------|------------------------------|-------------|----------------|------------------------------|-------------|----------------|
| 307 | 0.6016 | 1.2% | 325 | 0.6367 | 1.1% | 343 | 0.6719 | 1.0% |
| 308 | 0.6016 | 1.2% | 326 | 0.6367 | 1.1% | 344 | 0.6719 | 1.0% |
| 309 | 0.6055 | 1.2% | 327 | 0.6406 | 1.0% | 345 | 0.6758 | 1.0% |
| 310 | 0.6055 | 1.2% | 328 | 0.6406 | 1.0% | 346 | 0.6758 | 1.0% |
| 311 | 0.6094 | 1.2% | 329 | 0.6445 | 1.0% | 347 | 0.6797 | 1.0% |
| 312 | 0.6094 | 1.2% | 330 | 0.6445 | 1.0% | 348 | 0.6797 | 1.0% |
| 313 | 0.6133 | 1.2% | 331 | 0.6484 | 1.0% | 349 | 0.6836 | 1.0% |
| 314 | 0.6133 | 1.2% | 332 | 0.6484 | 1.0% | 350 | 0.6836 | 1.0% |
| 315 | 0.6172 | 1.1% | 333 | 0.6523 | 1.0% | 351 | 0.6875 | 1.0% |
| 316 | 0.6172 | 1.1% | 334 | 0.6523 | 1.0% | 352 | 0.6875 | 1.0% |
| 317 | 0.6211 | 1.1% | 335 | 0.6563 | 1.0% | 353 | 0.6914 | 1.0% |
| 318 | 0.6211 | 1.1% | 336 | 0.6563 | 1.0% | 354 | 0.6914 | 1.0% |
| 319 | 0.6250 | 1.1% | 337 | 0.6602 | 1.0% | 355 | 0.6953 | 1.0% |
| 320 | 0.6250 | 1.1% | 338 | 0.6602 | 1.0% | 356 | 0.6953 | 1.0% |
| 321 | 0.6289 | 1.1% | 339 | 0.6641 | 1.0% | 357 | 0.6992 | 1.0% |
| 322 | 0.6289 | 1.1% | 340 | 0.6641 | 1.0% | 358 | 0.6992 | 1.0% |
| 323 | 0.6328 | 1.1% | 341 | 0.6680 | 1.0% | 359 | 0.7031 | 1.0% |
| 324 | 0.6328 | 1.1% | 342 | 0.6680 | 1.0% | 360 | 0.7031 | 1.0% |

The divider resistors are then given by Equation 5.

Equation 5:

$$R_{FB1} = V_{OUT} \times \left(\frac{R_{PAR}}{V_{REF}} \right)$$

$$R_{FB2} = R_{FB1} \times \left(\frac{R_{PAR}}{R_{FB1} - R_{PAR}} \right)$$

where:

R_{FB1} = Top divider resistor

R_{FB2} = Bottom divider resistor

R_{PAR} = Desired parallel resistance of R_{FB1} and R_{FB2}

V_{OUT} = Output voltage

V_{REF} = Reference voltage = 0.6016V to 1V (set by DAC)

Table 8. Voltage vs. PMBus VOUT_COMMAND (continued)

| VOUT COMMAND [9:0] (decimal) | VOLTAGE (V) | ACCURACY (+/-) | VOUT COMMAND [9:0] (decimal) | VOLTAGE (V) | ACCURACY (+/-) | VOUT COMMAND [9:0] (decimal) | VOLTAGE (V) | ACCURACY (+/-) |
|---------------------------------------|----------------|-------------------|---------------------------------------|----------------|-------------------|---------------------------------------|----------------|-------------------|
| 361 | 0.7070 | 1.0% | 396 | 0.7734 | 1.0% | 431 | 0.8438 | 1.0% |
| 362 | 0.7070 | 1.0% | 397 | 0.7773 | 1.0% | 432 | 0.8438 | 1.0% |
| 363 | 0.7109 | 1.0% | 398 | 0.7773 | 1.0% | 433 | 0.8477 | 1.0% |
| 364 | 0.7109 | 1.0% | 399 | 0.7813 | 1.0% | 434 | 0.8477 | 1.0% |
| 365 | 0.7148 | 1.0% | 400 | 0.7813 | 1.0% | 435 | 0.8516 | 1.0% |
| 366 | 0.7148 | 1.0% | 401 | 0.7852 | 1.0% | 436 | 0.8516 | 1.0% |
| 367 | 0.7188 | 1.0% | 402 | 0.7852 | 1.0% | 437 | 0.8555 | 1.0% |
| 368 | 0.7188 | 1.0% | 403 | 0.7891 | 1.0% | 438 | 0.8555 | 1.0% |
| 369 | 0.7227 | 1.0% | 404 | 0.7891 | 1.0% | 439 | 0.8594 | 1.0% |
| 370 | 0.7227 | 1.0% | 405 | 0.7930 | 1.0% | 440 | 0.8594 | 1.0% |
| 371 | 0.7266 | 1.0% | 406 | 0.7930 | 1.0% | 441 | 0.8633 | 1.0% |
| 372 | 0.7266 | 1.0% | 407 | 0.7969 | 1.0% | 442 | 0.8633 | 1.0% |
| 373 | 0.7305 | 1.0% | 408 | 0.7969 | 1.0% | 443 | 0.8672 | 1.0% |
| 374 | 0.7305 | 1.0% | 409 | 0.8008 | 1.0% | 444 | 0.8672 | 1.0% |
| 375 | 0.7344 | 1.0% | 410 | 0.8008 | 1.0% | 445 | 0.8711 | 1.0% |
| 376 | 0.7344 | 1.0% | 411 | 0.8047 | 1.0% | 446 | 0.8711 | 1.0% |
| 377 | 0.7383 | 1.0% | 412 | 0.8047 | 1.0% | 447 | 0.8750 | 1.0% |
| 378 | 0.7383 | 1.0% | 413 | 0.8086 | 1.0% | 448 | 0.8750 | 1.0% |
| 379 | 0.7422 | 1.0% | 414 | 0.8086 | 1.0% | 449 | 0.8789 | 1.0% |
| 380 | 0.7422 | 1.0% | 415 | 0.8125 | 1.0% | 450 | 0.8789 | 1.0% |
| 381 | 0.7461 | 1.0% | 416 | 0.8125 | 1.0% | 451 | 0.8828 | 1.0% |
| 382 | 0.7461 | 1.0% | 417 | 0.8164 | 1.0% | 452 | 0.8828 | 1.0% |
| 383 | 0.7500 | 1.0% | 418 | 0.8164 | 1.0% | 453 | 0.8867 | 1.0% |
| 384 | 0.7500 | 1.0% | 419 | 0.8203 | 1.0% | 454 | 0.8867 | 1.0% |
| 385 | 0.7539 | 1.0% | 420 | 0.8203 | 1.0% | 455 | 0.8906 | 1.0% |
| 386 | 0.7539 | 1.0% | 421 | 0.8242 | 1.0% | 456 | 0.8906 | 1.0% |
| 387 | 0.7578 | 1.0% | 422 | 0.8242 | 1.0% | 457 | 0.8945 | 1.0% |
| 388 | 0.7578 | 1.0% | 423 | 0.8281 | 1.0% | 458 | 0.8945 | 1.0% |
| 389 | 0.7617 | 1.0% | 424 | 0.8281 | 1.0% | 459 | 0.8984 | 1.0% |
| 390 | 0.7617 | 1.0% | 425 | 0.8320 | 1.0% | 460 | 0.8984 | 1.0% |
| 391 | 0.7656 | 1.0% | 426 | 0.8320 | 1.0% | 461 | 0.9023 | 1.0% |
| 392 | 0.7656 | 1.0% | 427 | 0.8359 | 1.0% | 462 | 0.9023 | 1.0% |
| 393 | 0.7695 | 1.0% | 428 | 0.8359 | 1.0% | 463 | 0.9063 | 1.0% |
| 394 | 0.7695 | 1.0% | 429 | 0.8398 | 1.0% | 464 | 0.9063 | 1.0% |
| 395 | 0.7734 | 1.0% | 430 | 0.8398 | 1.0% | 465 | 0.9102 | 1.0% |

Table 8. Voltage vs. PMBus VOUT_COMMAND (continued)

| VOUT COMMAND [9:0] (decimal) | VOLTAGE (V) | ACCURACY (+/-) | VOUT COMMAND [9:0] (decimal) | VOLTAGE (V) | ACCURACY (+/-) | VOUT COMMAND [9:0] (decimal) | VOLTAGE (V) | ACCURACY (+/-) |
|---------------------------------------|----------------|-------------------|---------------------------------------|----------------|-------------------|---------------------------------------|----------------|-------------------|
| 466 | 0.9102 | 1.0% | 482 | 0.9414 | 1.0% | 498 | 0.9727 | 1.0% |
| 467 | 0.9141 | 1.0% | 483 | 0.9453 | 1.0% | 499 | 0.9766 | 1.0% |
| 468 | 0.9141 | 1.0% | 484 | 0.9453 | 1.0% | 500 | 0.9766 | 1.0% |
| 469 | 0.9180 | 1.0% | 485 | 0.9492 | 1.0% | 501 | 0.9805 | 1.0% |
| 470 | 0.9180 | 1.0% | 486 | 0.9492 | 1.0% | 502 | 0.9805 | 1.0% |
| 471 | 0.9219 | 1.0% | 487 | 0.9531 | 1.0% | 503 | 0.9844 | 1.0% |
| 472 | 0.9219 | 1.0% | 488 | 0.9531 | 1.0% | 504 | 0.9844 | 1.0% |
| 473 | 0.9258 | 1.0% | 489 | 0.9570 | 1.0% | 505 | 0.9883 | 1.0% |
| 474 | 0.9258 | 1.0% | 490 | 0.9570 | 1.0% | 506 | 0.9883 | 1.0% |
| 475 | 0.9297 | 1.0% | 491 | 0.9609 | 1.0% | 507 | 0.9922 | 1.0% |
| 476 | 0.9297 | 1.0% | 492 | 0.9609 | 1.0% | 508 | 0.9922 | 1.0% |
| 477 | 0.9336 | 1.0% | 493 | 0.9648 | 1.0% | 509 | 0.9961 | 1.0% |
| 478 | 0.9336 | 1.0% | 494 | 0.9648 | 1.0% | 510 | 0.9961 | 1.0% |
| 479 | 0.9375 | 1.0% | 495 | 0.9688 | 1.0% | 511 | 1.0000 | 1.0% |
| 480 | 0.9375 | 1.0% | 496 | 0.9688 | 1.0% | 512 | 1.0000 | 1.0% |
| 481 | 0.9414 | 1.0% | 497 | 0.9727 | 1.0% | — | — | — |

Notes: The repeated voltage values in the table are due to ignoring the LSB in hardware. The available V_{BOOT} values are highlighted in gray. Voltages shown are referenced to the sense pins. Actual V_{OUT} can be scaled by a voltage-divider in the feedback.

Control-Loop Stability

The IC uses valley current-mode control which is stabilized by selecting appropriate values of C_{OUT} and R_{GAIN} . No compensation network is required. For stability, the loop bandwidth (BW) should be 100kHz or less. Consider the case of using MLCC output capacitors that have nearly ideal impedance characteristics in the frequency range of interest with negligible ESR and ESL. The loop bandwidth can be approximated by breaking the loop into gain terms as outlined below.

- 1) The IC’s valley current-mode control scheme has an effective transconductance gain of $1/R_{GAIN}$.
- 2) For MLCC capacitors, the output capacitors contribute an impedance gain of $1/(2 \times \pi \times C_{OUT} \times f)$.
- 3) The feedback-divider contributes an attenuation of $K_{DIV} = R_{FB2}/(R_{FB1} + R_{FB2})$.
- 4) An inherent high-frequency pole located at 150kHz.

When the BW is 100kHz or less, the high-frequency pole can be ignored and the approximate loop gain and BW are given by Equation 6.

Equation 6:

$$|LOOP_GAIN(f)| = \frac{K_{DIV}}{2 \times \pi \times R_{GAIN} \times C_{OUT} \times f}$$

$$BW = \frac{K_{DIV}}{2 \times \pi \times R_{GAIN} \times C_{OUT}}$$

OR

$$BW = \frac{1}{2 \times \pi \times R_{GAIN_EFF} \times C_{OUT}}$$

where:

$$R_{GAIN_EFF} = R_{GAIN}/K_{DIV}$$

For stability, R_{GAIN} and C_{OUT} should be chosen so that $BW < 100kHz$.

The available R_{GAIN} settings are shown in Table 4. When choosing which R_{GAIN} setting to use, one should consider that while higher R_{GAIN} allows the loop to be stabilized with less C_{OUT} , less C_{OUT} generally results in higher ripple and larger transient overshoot and undershoot, so there needs to be a balance.

Integrator

The IC has an integrator included in its error amplifier, which was ignored in the above equations for simplicity. The integrator only adds gain at low frequencies, so it does not really effect the loop BW calculation. The purpose of the integrator is to improve load regulation. The integrator adds a factor of $(1/t_{REC} + s)/s$ to the loop gain.

Step Response

R_{GAIN_EFF} is important because it determines the small-signal transient response of the regulator. When a load step is applied that does not exceed the slew-rate capability of the inductor current, the regulator responds linearly and V_{OUT} temporarily changes by the amount of V_{OUT_ERROR} (see Equation 7).

Equation 7:

$$V_{OUT_ERROR} = I_{STEP} \times R_{GAIN_EFF}$$

The integrator causes V_{OUT} to recover to the nominal value with a time constant of $t_{REC} = 20\mu s$. The regulator can be modeled to a first-order by the averaged small-signal equivalent circuit shown in Figure 4. Here, V_{EQ} is an ideal voltage source, R_{EQ} is an equivalent lossless resistance created by the control-loop action, and L_{EQ} is an equivalent inductance. Note that L_{EQ} is not the same as the actual L_{OUT} inductor that has been absorbed into the model. C_{OUT} is the actual output capacitance.

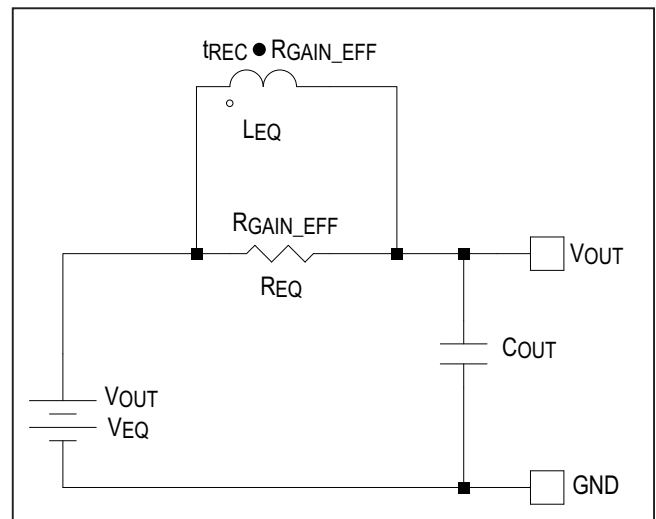


Figure 4. Averaged Small-Signal Equivalent Circuit of Regulator

Note: The large-signal transient response is approximately the larger between the V_{OUT_ERROR} and the unloading transient.

Output-Capacitor ESR

In the above control-loop discussion, the case of MLCC output capacitors has been considered. Another case worth mentioning is the use of output capacitors with more significant ESR. This can be considered as long as the capacitors are rated to handle the inductor current ripple and expected surge currents. Thus far, it has been assumed that C_{OUT} is comprised of MLCCs and the net ESR is negligible compared to R_{GAIN}/K_{DIV} . If the net ESR of the C_{OUT} bank is not negligible compared to R_{GAIN}/K_{DIV} , the inductor current ripple is effectively sensed by the ESR and adds to the R_{GAIN_EFF} , as shown in Equation 8.

Equation 8:

$$R_{GAIN_EFF} = \frac{R_{GAIN}}{K_{DIV}} + ESR$$

The capacitor's ESR also introduces a zero into the loop gain. The inherent high-frequency pole helps to compensate this zero. For a more in-depth view of the effect of circuit values on regulator performance, the Maxim Simplis model and MAX20734 evaluation kit can be used. It is recommended to simulate and/or test regulator performance when using values other than the recommended component values.

The performance data shown in the [Typical Operating Characteristics](#) section was taken using the MAX20734 evaluation kit and component values in [Table 7](#). For most applications, these are the optimum values to use. [Table 9](#), [Table 10](#), and [Table 11](#) show suitable part numbers for input and output capacitors and the inductor.

Table 9. Recommended Inductors

| COMPANY | VALUE (nH) | I _{SAT} (A) | R _{DC} (mΩ) | FOOTPRINT (mm) | HEIGHT (mm) | PART NUMBER | WEBSITE |
|---------|------------|----------------------|----------------------|----------------|-------------|----------------|--------------------------|
| Cooper | 170 | 60 | 0.29 | 10.4 x 8.0 | 7.5 | FP1007R3-R17-R | www.cooperindustries.com |
| Pulse | 215 | 41 | 0.29 | 10.4 x 7.9 | 7.3 | PA2607.211NL | www.pulseelectronics.com |
| Pulse | 270 | 34 | 0.29 | 10.4 x 7.9 | 7.3 | PA2607.271NL | www.pulseelectronics.com |
| Pulse | 320 | 45 | 0.32 | 13.5 x 13.0 | 8.0 | PA0513.321NLT | www.pulseelectronics.com |
| Pulse | 440 | 30 | 0.32 | 13.5 x 13.0 | 8.0 | PA0513.441NLT | www.pulseelectronics.com |

Table 10. MLCC Input Capacitors

| CASE SIZE | VALUE (μF) | TEMPERATURE RATING | VOLTAGE RATING | T (mm) (NOTE 1) | COMPANY | PART NUMBER |
|-----------|------------|--------------------|-------------------|----------------------|----------------------|------------------------------------------------------|
| 0603 | 1 | X7S X7R | 16V | 0.8 (Note 2) | Murata TDK | GRM188C71C105KA12D C1608X7R1C105K |
| 0805 | 2.2 | X7R | 25V 16V 16V | 1.25 1.25 1.25 | Murata TDK AVX | GRM21BR71E225KA73L C2012X7R1C225M 0805YC225MAT |
| 0805 | 4.7 | X7R | 16V | 1.25 | Murata | GRM21BR71C475K |
| 1206 | 4.7 | X7R | 16V | 1.65 | AVX Murata | 1206YC475MAT GRM31CR71C475KA01L |
| 1206 | 10 | X7R | 16V | 1.65 | Murata TDK AVX | GRM31CR71C106KAC7L C3216X7R1C106M 1206YC106MAT |
| 1210 | 10 | X7R | 16V 25V | 2.0 2.5 | Murata TDK | GRM32DR71C106KA01L C3225X7R1E106M |
| 1210 | 22 | X7R | 16V | 2.45 2.5 2.5 | AVX Murata TDK | 1210YC226MAT GRM32ER71A476K C3225X7R1C226M |

Note 1: T indicates nominal thickness.**Note 2:** Indicates capacitors with nominal thickness smaller than the minimum FCQFN package thickness.

Table 11. Recommended Output Capacitors

| COMPANY | VALUE (μF) | PART NUMBER | TEMPERATURE RATING | VOLTAGE RATING | CASE SIZE | T (mm) (Note 1) | WEBSITE |
|-------------|------------|--------------------|--------------------|----------------|-----------|-----------------|-----------------------|
| AVX Corp. | 22 | 08054D226MAT2A | X5R | 4V | 0805 | 1.3 | www.avxcorp.com |
| | 22 | 12066D226MAT2A | X5R | 6.3V | 1206 | 1.65 | |
| Murata | 22 | GRM21BR60J226ME39L | X5R | 6.3V | 0805 | 1.25 | www.murata.co.jp |
| | 22 | GRM31CR60J226KE19L | X5R | 6.3V | 1206 | 1.6 | |
| | 22 | GRM32DR60J226KA01L | X5R | 6.3V | 1210 | 2.0 | |
| Panasonic | 22 | ECJ3YB0J226M | X5R | 6.3V | 1206 | 1.6 | www.panasonic.com |
| | 22 | ECJHVB0J226M | X5R | 6.3V | 1206 | 0.85 | |
| | 22 | ECJ3Y70J226M | X7R | 6.3V | 1206 | 1.65 | |
| Taiyo Yuden | 22 | AMK212BJ226MG | X5R | 4V | 0805 | 1.25 | www.taiyo-yuden.com |
| | 22 | JMK316BJ226ML | X5R | 6.3V | 1206 | 1.6 | |
| | 22 | JMK325BJ226MY | X5R | 6.3V | 1210 | 1.9 | |
| TDK Corp. | 22 | C2012X5R0J226M | X5R | 6.3V | 0805 | 1.25 | www.component.tdk.com |
| | 22 | C3216X5R0J226M | X5R | 6.3V | 1206 | 1.6 | |
| | 22 | C3225X5R0J226M | X5R | 6.3V | 1210 | 1.6 | |
| | 22 | C3216X6S0J226M | X6S | 6.3V | 1206 | 1.6 | |

Note 1: T indicates nominal thickness.

Inductor Selection

The output inductor has an important influence on the overall size, cost, and efficiency of the voltage regulator. Since the inductor is typically one of the larger components in the system, a minimum inductor value is particularly important in space-constrained applications. Smaller inductor values also permit faster transient response, reducing the amount of output cap needed to maintain transient tolerances.

For any buck regulator, the maximum current slew rate through the output inductor is given by Equation 9.

Equation 9:

$$\text{SlewRate} = \frac{dI_L}{dt} = \frac{V_L}{L_{OUT}}$$

where:

I_L = Inductor current

L_{OUT} = Output inductance

$V_L = V_{DDH} - V_{OUT}$ during high-side FET conduction and $-V_{OUT}$ during low-side FET conduction

Equation 9 shows that larger inductor values limit the regulator's ability to slew current through the output inductor in response to step-load transients. Consequently, more output capacitors are required to supply (or store) sufficient charge to maintain regulation while the inductor current ramps up to supply the load.

In contrast, smaller inductor values increase the regulator's maximum achievable slew rate and decrease the necessary capacitance, at the expense of higher ripple current. The peak-to-peak ripple current is given by Equation 10.

Equation 10:

$$I_{OUTRIPPLE} = \frac{t_{H_ON} \times (V_{DDH} - V_{OUT})}{L_{OUT}}$$

where:

t_{H_ON} = High-side switch on-time (based on nominal V_{OUT}) (see Equation 1)

L_{OUT} = Output inductance

V_{DDH} = Input voltage

V_{OUT} = Output voltage

From Equation 10, for the same switching frequency and ripple current increases as L decreases. This increased ripple current results in increased AC losses, larger peak current, and for the same output capacitance, results in increased output voltage ripple.

$I_{OUTRIPPLE}$ should be set to 25% to 50% of the IC's rated output current. A suitable inductor value can then be found by solving Equation 10 for inductance as in Equation 11 and Equation 12.

Equation 11:

$$L_{OUT} = \frac{V_{OUT}(V_{DDH} - V_{OUT})}{V_{DDH} \times I_{OUTRIPPLE} \times f_{SW}}$$

Assuming $I_{OUTRIPPLE} = 0.5 \times I_{OUT}$ for a typical inductor value, see Equation 12.

Equation 12:

$$L_{OUT} = \frac{V_{OUT}(V_{DDH} - V_{OUT})}{V_{DDH} \times (0.5 \times I_{OUT}) \times f_{SW}}$$

For a 25A regulator running at 400kHz, with $V_{DDH} = 12V$ and $V_{OUT} = 1V$, Equation 13 shows the target value for the inductor.

Equation 13:

$$L_{OUT} = \frac{1 \times (12 - 1)}{12 \times 0.5 \times 25 \times 400000} \\ = 183nH$$

The saturation current rating of the inductor is another important consideration. At current limit, the peak inductor current is given in Equation 14.

Equation 14:

$$I_{PK} = I_{OCP} + I_{OUTRIPPLE}$$

where:

I_{OCP} = Overcurrent protection trip point (see the [Electrical Characteristics](#) table and the [Current Limiting and Short-Circuit Protection](#) section)

$I_{OUTRIPPLE}$ = Peak-to-peak inductor current ripple, as defined above

For proper OCP operation of the regulator, it is important that I_{PK} never exceeds the saturation current rating of the inductor (I_{SAT}). It is recommended that a margin of at least 20% is included between I_{PK} and I_{SAT} , as shown in Equation 15.

Equation 15:

$$I_{SAT} > 1.2 \times I_{PK}$$

Also, note that during a hard V_{OUT} short circuit, $I_{OUTRIPPLE}$ increases due to V_{OUT} going to zero in Equation 10.

Finally, the power dissipation of the inductor influences the regulation efficiency. Losses in the inductor include core loss, DC resistance loss, and AC resistance loss. For the best efficiency, use inductors with core material exhibiting low loss in the range of 0.5MHz to 2MHz, and low-winding resistance.

[Table 9](#) provides a summary of the recommended inductor suppliers and part numbers.

Output Capacitor Selection

The minimum recommended output capacitance for stability is described in the [Control-Loop Stability](#) section and is normally implemented using several 100 μ F 1206 (or similar) MLCCs. For low slew-rate transient loads, R_{GAIN_EFF} determines the V_{OUT_ERROR} for a given load step per the small-signal model, as discussed above. In this case, C_{OUT} has no effect on the V_{OUT_ERROR} .

However, in the event that the slew rate of the load transient greatly exceeds the slew rate of the inductor current, the transient V_{OUT_ERROR} may be larger than predicted by the small-signal model. In this case, the V_{OUT} loading and unloading transients can be approximated by taking the larger result between Equation 7 and Equation 16.

Equation 16:

$$LOADINGTRANSIENT(V) = \frac{L_{OUT} \times \left(I_{STEP} + \frac{I_{OUTRIPPLE}}{2} \right)^2}{2 \times C_{OUT} \times (V_{DDH} - V_{OUT})}$$

$$UNLOADINGTRANSIENT(V) = \frac{L_{OUT} \times \left(I_{STEP} + \frac{I_{OUTRIPPLE}}{2} \right)^2}{2 \times C_{OUT} \times V_{OUT}} \\ + I_{STEP} \times \frac{t_{H_ON}}{C_{OUT}}$$

In order to meet an aggressive transient specification, C_{OUT} may have to be increased and/or L_{OUT} decreased; however, note that decreasing L_{OUT} results in larger inductor ripple current; thus, decreased efficiency and increased output ripple.

Output voltage ripple is another important consideration in the selection of output capacitors. For a buck regulator operating in CCM, the total voltage ripple across the output capacitor bank can be approximated as the sum of three voltage waveforms: 1) the triangle wave that results from multiplying the AC ripple current by the ESR, 2) the square wave that results from multiplying the ripple current slew rate by the ESL, and 3) the piecewise quadratic waveform that results from charging/discharging the output capacitor. Although the phasing of these three components impacts the total output ripple, a common approximation is to ignore the phasing and to find the upper bound of the peak-to-peak ripple by summing all three components, as shown in Equation 17.

Equation 17:

$$V_{P-P} = ESR(I_{OUTRIPPLE}) + ESL \left(\frac{V_{DDH}}{L_{OUT}} \right) + \left(\frac{I_{OUTRIPPLE}}{8 \times f_{SW} \times C_{OUT}} \right)$$

where:

ESR = Equivalent series resistance at the output

$I_{OUTRIPPLE}$ = Peak-to-peak inductor current ripple

ESL = High-frequency equivalent series inductance at output

V_{DDH} = Input voltage

L_{OUT} = Output inductance

f_{SW} = Switching frequency

C_{OUT} = Output capacitance

In a typical MAX20734 application with a bank of 0805, X5R, 6.3V, 22 μ F output capacitors, these three components are roughly equal.

The ESL effect of an output capacitor on output voltage ripple cannot be easily estimated from the resonant frequency so the high-frequency (10MHz or above) impedance of that capacitor should be used instead. PCB traces and vias in the V_{OUT}/GND loop contribute additional parasitic inductance.

The final considerations in the selection of output capacitors are ripple-current rating and power dissipation. Using a conservative design approach, the output capacitors should be designed to handle the maximum peak-to-peak AC ripple current experienced in the worst-case scenario. Because the recommended output capacitors have extremely low ESR values, they are typically rated well above the current and power stresses seen here. For

the triangular AC ripple current at the output, the total RMS current and power is given by Equation 18 and Equation 19.

Equation 18:

$$I_{RMS_COUT} = \frac{I_{OUTRIPPLE}}{\sqrt{12}}$$

where:

$I_{OUTRIPPLE}$ = Peak-to-peak ripple current value

Equation 19:

$$P_{COUT} = I_{RMS_COUT}^2 \times ESR$$

where:

ESR = Equivalent series resistance of the entire output capacitor bank

Input Capacitor Selection

The selection and placement of input capacitors are important considerations. High-frequency input capacitors serve to control switching noise. Bulk input capacitors are designed to filter the pulsed DC current that is drawn by the regulator. For the best performance, lowest cost, and smallest size of the MAX20734 systems, MLCC capacitors with 1210 or smaller case sizes, capacitance values of 47 μ F or smaller, 16V or 25V voltage ratings, and X5R or better temperature characteristics are recommended as bulk. The minimum recommended value of capacitance are 2 x 47 μ F (bulk) and 1.0 μ F + 0.1 μ F (high frequency). Smaller values of bulk capacitance can be used in direct proportion to the maximum load current.

It is recommended to choose the main MLCC input capacitance to control the peak-to-peak input-voltage ripple to 2% to 3% of its DC value in accordance with Equation 20.

Equation 20:

$$C_{IN} = \frac{I_{MAX} \times V_{OUT} \times (V_{DDH} - V_{OUT})}{(f_{SW} \times V_{DDH}^2 \times V_{INPP})}$$

where:

C_{IN} = Input capacitance (MLCC)

I_{MAX} = Maximum load current

V_{DDH} = DC input voltage

V_{OUT} = DC output voltage

f_{SW} = Switching frequency

V_{INPP} = Target peak-to-peak input-voltage ripple

Because the bulk input capacitors must source the pulsed DC input current of the regulator, the power dissipation and ripple current rating for these capacitors are far more important than that for the output capacitors. The RMS current that the input capacitor must withstand can be approximated using Equation 21.

Equation 21:

$$I_{RMS_CIN} = \frac{I_{LOAD} \sqrt{V_{OUT} (V_{DDH} - V_{OUT})}}{V_{DDH}}$$

where:

I_{LOAD} = Output DC load current

With an equivalent series resistance of the bulk input capacitor bank (ESR_{CIN}), the total power dissipation in the input capacitors is given by Equation 22.

Equation 22:

$$P_{CIN} = I_{RMS_CIN}^2 \times ESR_{CIN}$$

Resistor Selection and its Effect on DC Output-Voltage Accuracy

R_{FB1} and R_{FB2} set the output voltage, as described in Equation 4. The tolerance of these resistors affects the

accuracy of the set output voltage. Due to the form of Equation 4, the effect is higher at higher output voltages.

Figure 5 shows the effect of 0.1% tolerance resistors over a range of output voltages. For different tolerance resistors, multiply the output voltage error by the resistors' tolerances divided by 0.1% (e.g., for 0.5% tolerance resistors, multiply the output error shown by 5). To obtain accuracy over temperature, for a worst-case scenario, the temperature coefficients multiplied by the temperature range should be added to the tolerance (i.e., for 25ppm/°C resistors over a 50°C excursion, add 0.125% to the 25°C tolerance).

The error due to the voltage feedback resistors' tolerance (R_{FB1} and R_{FB2}) should be added to the output-voltage tolerance due to the IC's feedback-voltage accuracy shown in the *Electrical Characteristics* table.

Voltage Margining

Voltage margining can be achieved by changing the V_{OUT} setting through PMBus. V_{OUT} changes occur with a default linear slew rate of 1V/ms. The slew rate can be set to 1, 2, or 4mV/μs using the V_{RATE} bits. Refer to the AN6140: *MAX20734 PMBus Application Note* for details. If a voltage-divider is present in the feedback loop, the V_{OUT} slew rate will be scaled accordingly.

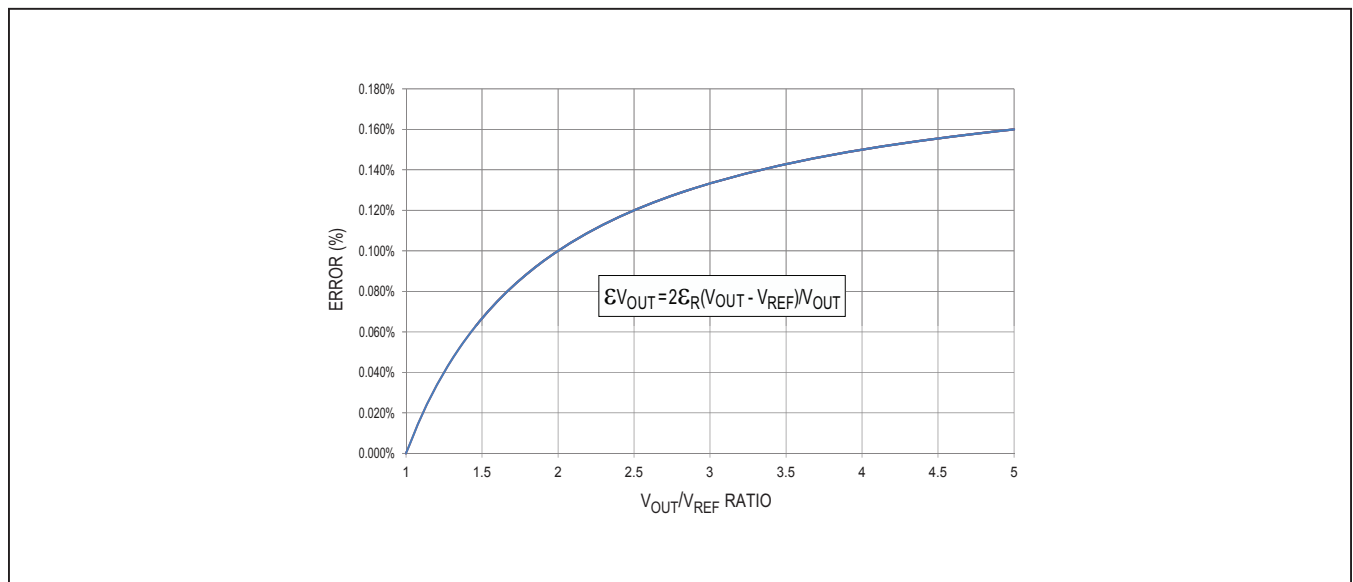


Figure 5. DC Accuracy Impact Showing Effect of 0.1% Tolerance for R_{FB1} and R_{FB2}

PCB Layout Guidelines

PCB layout can dramatically affect the performance of the regulator. A poorly designed board can degrade efficiency, noise performance, and even control-loop stability. At higher switching frequencies, layout issues are especially critical.

As a general guideline, the input capacitors and the output inductor should be placed in close proximity to the regulator IC, while the output capacitors should be lumped together as close as possible to the load. Traces to these components should be kept as short and wide as possible to minimize parasitic inductance and resistance. Traces connecting the input capacitors and V_{DDH} (power input node) on the IC require particular attention since they carry currents with the largest RMS values and fastest slew rates. According to best practice, the input capacitors should be placed as close as possible to the input supply pins, with the smallest package high-frequency capacitor being the closest to the IC and no more than 60 mils from the IC pins. Preferably, there should be an uninterrupted ground plane located immediately underneath these high-frequency current paths, with the ground plane located no more than 8 mils below the top layer. By keeping the flow of this high-frequency AC current localized to a tight loop at the regulator, electromagnetic interference (EMI) can be minimized.

Voltage-sense lines should be routed differentially directly from the load points. The ground plane can be used as a shield for these or other sensitive signals to protect them from capacitive or magnetic coupling of high-frequency noise.

For remote-sense applications where the load and regulator IC are separated by a significant distance or impedance, it is important to place the majority of the output capacitors directly at the load. Ideally, for system stability, all the output capacitors should be placed as close as possible to the load. In remote-sense applications, common-mode filtering is necessary to filter high-frequency noise in the sense lines.

The following layout recommendations should be used for optimal performance:

- It is essential to have a low-impedance and uninterrupted ground plane under the IC and extended out underneath the inductor and output capacitor bank.
- Multiple vias are recommended for all paths that carry high currents (i.e., GND, V_{DDH} , VX). Vias should be placed close to the chip to create the shortest possible current loops. Via placement must not obstruct the flow of currents or mirror currents in the ground plane.
- A single via in close proximity to the chip should be used to tie the top layer A_{GND} trace to the second layer ground plane, it must not be connected to the top power ground area.
- The feedback-divider and compensation network should be close to the IC to minimize the noise on the IC side of the divider.

Gerber files with layout information and complete reference designs can be obtained by contacting a Maxim account representative.

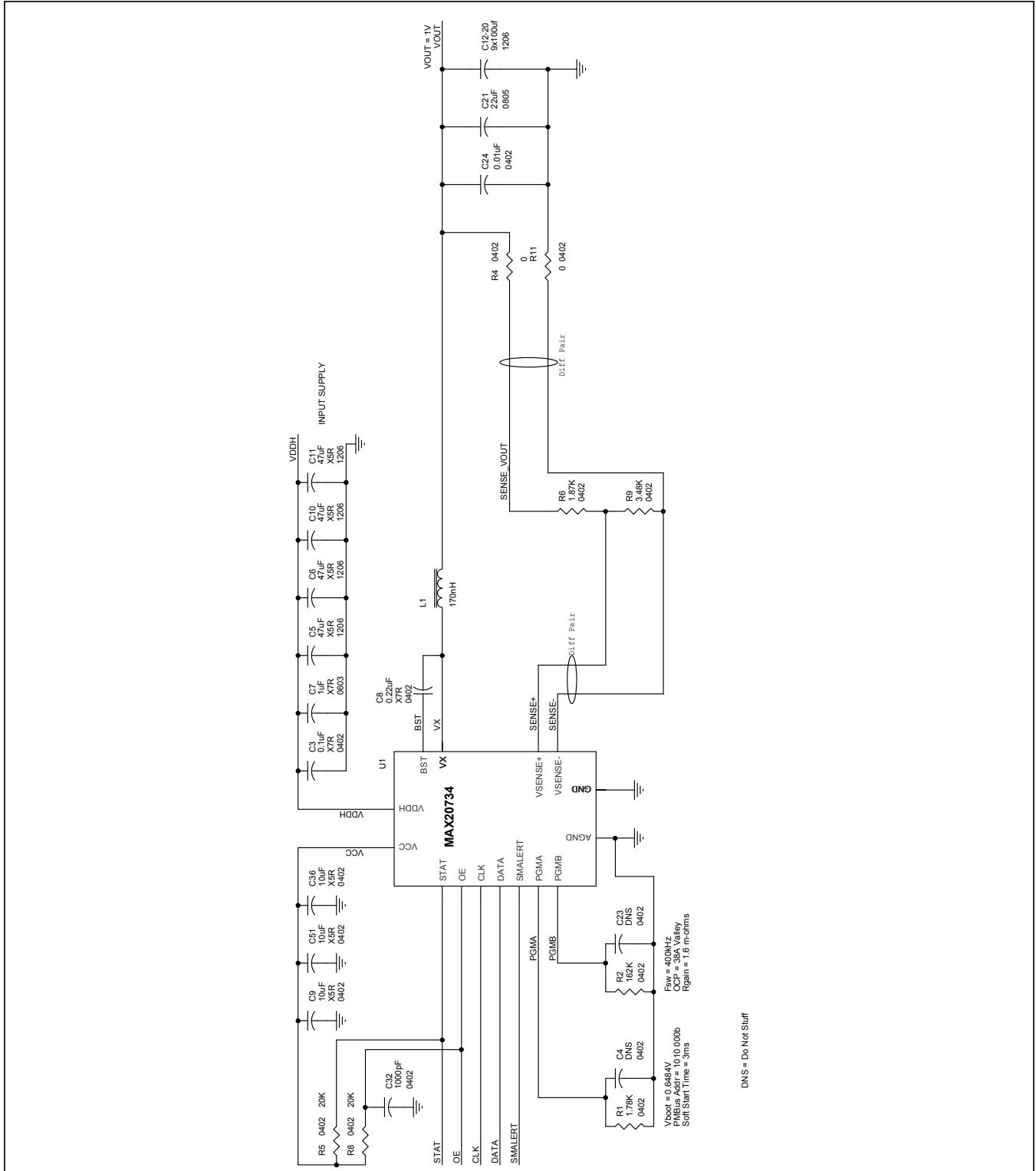


Figure 6. Reference Schematic (V_{OUT} = 1V, V_{DDH} = 4.5V to 16V)

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
|---------------|-----------------|-------------|
| MAX20734EPL+ | -40°C to +125°C | 15 FCQFN |
| MAX20734EPL+T | -40°C to +125°C | 15 FCQFN |

+Denotes a lead(Pb)-free/RoHS-compliant package.
T = Tape and reel.

Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
|-----------------|---------------|-----------------|---------------|
| 0 | 1/17 | Initial release | — |

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